

## Support SCP, Bi-directional PD3.0 , Fast Charge protocol , Wireless charging automatic wake-up Power Bank SOC

### 1. Features

- **Support multiple ports simultaneously**
  - ✧ 1 USB A output ports
  - ✧ 1 USB C input / output port
  - ✧ Wireless charging TX
  - ✧ Support wireless charging, USB output or input work simultaneously
- **WPC Qi compliant**
  - ✧ Supports BPP, PPDE, EPP protocols
- **Wireless charging**
  - ✧ Support 5W/7.5W/10W/15W TX
  - ✧ External full-bridge power MOS
  - ✧ Integrated ASK communication demodulation module
  - ✧ Support CBB/NPO capacitor
- **Integrated wireless charging function**
  - ✧ Support no-load and on-load foreign object detection
  - ✧ Support coil NTC temperature detection
  - ✧ Support coil voltage maximum amplitude Limit
  - ✧ Support wireless charging automatic wake up
- **Fast charge**
  - ✧ Every port support fast charge
  - ✧ Support QC2.0 / QC3.0 output
  - ✧ Support FCP / AFC input / output
  - ✧ Support high voltage SCP output
  - ✧ Support USB C DRP input / output
  - ✧ Support BC1.2 / Apple / Samsung
  - ✧ PDO: 5V@3A、9V@2.22A、12V@1.67A 3.3V~11V@2A
- **Integrated USB PD2.0 / PD3.0 protocol**
  - ✧ Support PD2.0 input / output protocol
  - ✧ Support PD3.0 input / output and PPS output protocol
  - ✧ Support 5V、9V、12V voltage input/output
  - ✧ PPS support 3.3~11V adjustable voltage with 20mV / Step
  - ✧ Support BMC protocol
  - ✧ Integrated PHY Protocol
  - ✧ Integrated Hardware CRC
  - ✧ Support Hard Reset
- **Charger**
  - ✧ Support 18W charging power, Up to 5A

- charging current at battery port
- ✧ Adaptive charging current adjustment
- ✧ Support 4.20V、4.30V、4.35V、4.40V battery
- **Boost**
  - ✧ Output current:  
5V@3.1A 9V@2.22A 12V@1.67A
  - ✧ Up to 94%@5V@2A efficiency with synchronous switching
  - ✧ Support line compensate
- **Battery level display**
  - ✧ Integrated 14bit ADC and coulometer
  - ✧ Support 1/2 /4 LED battery level indicator
  - ✧ Support 88/188 nixie tube
  - ✧ Auto recognition of LED number
  - ✧ Supports battery capacity selection
- **Others**
  - ✧ Support auto detect of plug in and out
  - ✧ Fast charge status indicator
  - ✧ Support Battery NTC
  - ✧ Enter standby mode automatically in light load
  - ✧ Support I2C
- **Multiple protection,high reliability**
  - ✧ Input overvoltage and undervoltage protection
  - ✧ Output overcurrent,overvoltage and short circuit protection
  - ✧ Battery overcharge,over discharge and overcurrent protection
  - ✧ Over temperature protection
  - ✧ Input / Output battery temperature protection
  - ✧ 4kV ESD,Input voltage up to 20V ( including CC pins )
- **Low BOM cost**
  - ✧ Integrated switch power MOSFET
  - ✧ Single inductor for charging and discharging
- **Package size: 6mm x 6mm 0.5pitch QFN40**

### 2. Applications

- **Power Bank, Portable Charger**

## 3. Description

IP5561 is a power management SOC compliant with the WPC Qi standard. It integrates wireless charging and QC2.0/ QC3.0/SCP output fast charging protocol, FCP/ AFC input and output fast charging protocol, USB C/PD2.0/PD3.0 input and output protocol, USB C PD3.0 PPS output protocol, and BC1.2/Apple/ Samsung protocol. It integrates the functions of synchronous up / down converter, lithium battery charging management, battery power indication, etc. to provide a complete power solution for fast charging mobile power bank. one USB A port and one USB C port can be connected at the same time, any single USB port can support fast charging. When two or more output ports are used at the same time, only 5V is supported.

Only one inductor is needed to realize the function of buck and boost, and only a few peripheral devices are needed in the application, which effectively reduces the size of the overall PCB and reduces the cost of BOM.

The synchronous switch boost system of IP5561 can provide the maximum output capacity of 22.5W. When boost has no load, it will automatically enter the sleep mode.

IP5561 supports 18W charging and charging current up to 5.0A. Built in IC temperature, battery temperature and input voltage control loop, intelligent regulation of charging current.

IP5561 internally integrates H-bridge driver module, ASK communication demodulation module and other necessary wireless charging resources.

IP5561 integrates a 14bit ADC and current sensing circuit, which can accurately measure battery voltage and current. The algorithm of remaining battery capacity of IP5561 can accurately obtain battery level information. The battery capacity can be set to accurately display the remaining battery capacity.

IP5561 supports 1/2/4LED battery level indicator, and 88/188 digital tube battery level indicator. IP5561 supports lightning function and supports buttons.

## Contents

1. Features .....	1
2. Applications .....	1
3. Description .....	2
4. Reversion History .....	5
5. Typical Application .....	6
6. IP Series Products List .....	7
6.1. Power Bank IC .....	7
7. PIN Configuration and Functions .....	8
7.1. IP5561 Pin Functions .....	8
8. Functional Block Diagram .....	10
9. Absolute Maximum Ratings .....	11
10. Recommended Operating Conditions .....	11
11. Electrical Characteristics .....	12
12. Function Description .....	15
12.1. Low power lock out and activation .....	15
12.2. Charge .....	15
12.3. Boost .....	15
12.4. USB C .....	18
12.5. USB C PD .....	20
12.6. Fast Charge Protocol .....	20
12.7. Charge and Discharge Path Management .....	21
12.8. Automatic detection of mobile phone .....	23
12.9. KEY / nixie tube selection .....	23
12.10. Fast Charge state indication .....	23
12.11. Coulombmeter and battery level display .....	24
12.11.1. Battery level display for LED mode .....	24
12.11.2. 188 nixie tube display mode .....	25
12.11.3. Coulombmeter .....	26
12.12. VSET(Battery voltage selection) .....	27
12.13. NTC function .....	27
12.14. Wireless charging .....	29
12.14.1. H Bridge Drive .....	29
12.14.2. ASK communication demodulation/FSK modulation .....	29
12.14.3. Wireless Charging Indicators .....	30
12.14.4. Wireless Charging Automatic Wake Up .....	30
12.14.5. Wireless Charging Sampling Battery Voltage .....	31
12.14.6. FOD threshold setting .....	31
12.15. VCC .....	31
12.16. I2C .....	32
13. PCB Layout .....	33
13.1. Location of VOUT / VBUS / VWPC capacitor .....	33

---

13.2. Location of VSYS capacitor.....	33
13.3. Location of BAT/VCC/VDD/NTC capacitor.....	34
13.4. Wireless charging Sampling resistance.....	35
14. Typical Application Diagram.....	36
14.1. Power bank+TX+LED application.....	36
14.2. Power bank+TX+188 application.....	39
15. Package .....	42
15.1. Chip package.....	42
15.2. Silk Screen Description .....	43
16. IMPORTANT NOTICE.....	44

INJOINIC Corp

## 4. Reversion History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

<b>Change to Reversion V1.00 (Oct 2023)</b>	<b>Page</b>
• Preliminary release.....	1

---

<b>Change version V1.00 to V1.10 (Jan 2024)</b>	<b>Page</b>
• Added wireless charge automatic wake up description.....	1
• Schematic update.....	35

---

<b>Change version V1.10 to V1.11 (Feb 2024)</b>	<b>Page</b>
• Schematic diagram adds lithium protection circuit.....	35
• Electrical characteristics increase standby current of automatic wake up scheme.....	13

---

<b>Change version V1.11 to V1.12 (Mar 2024)</b>	<b>Page</b>
• Added the FOD threshold PIN.....	31
• Adding I2C applications.....	31

---

<b>Change version V1.12 to V1.20 (June 2024)</b>	<b>Page</b>
• Schematic adds OVP circuit.....	31

## 5. Typical Application

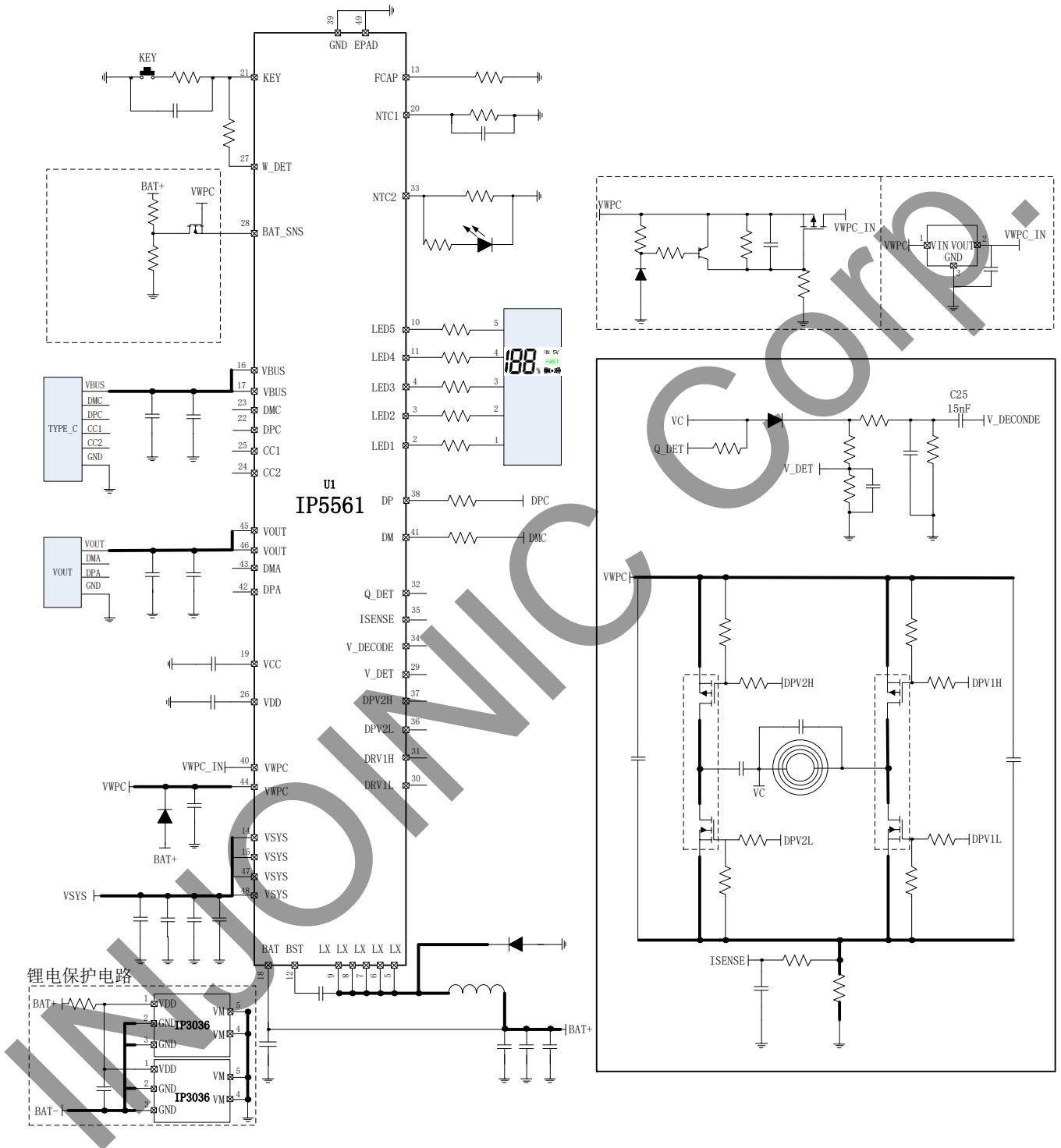


Figure 1 Simplified Application

## 6. IP Series Products List

### 6.1. Power Bank IC

IC Part No.	Charge/Boost Power		Main feature								Package	
	Boost Power	Charge Power	LED number	I2C	DCP	USB C	QC	PD3.0 /PPS	Super charge	UF CS	Package	Compatibility
IP5303T	5V/1A	5V/1A	1,2	-	-	-	-	-	-	-	ESOP8	PIN2PIN
IP5305T	5V/1A	5V/1A	1,2,3,4	√	-	-	-	-	-	-	ESOP8	
IP5306	5V/2.4A	5V/2A	1,2,3,4	√	-	-	-	-	-	-	ESOP8	
IP5306H	5V/2.4A	5V/2A	1,2,3,4	√	-	-	-	-	-	-	ESOP8	
IP5306P	5V/2.1A	5V/2A	1,2,4	√	-	-	-	-	-	-	ESOP8	
IP5316	5V/2.4A	5V2.4A	1,2,4	√	√	√	-	-	-	-	ESSOP10	
IP5326	5V/2.4A	5V2.4A	1,2,4	√	√	√	-	-	-	-	QFN16	
IP5407	5V/2.4A	5V/2A	1,2,4	-	√	-	-	-	-	-	ESOP8	-
IP5407H	5V/2.4A	5V/2.1A	1,2,4	-	√	-	-	-	-	-	ESOP8	
IP5209	5V/2.4A	5V/2.1A	3,4,5	√	√	-	-	-	-	-	QFN24	
IP5189T	5V/2.1A	5V/2A	1,2,3,4	√	√	-	-	-	-	-	QFN24	
IP5218	5V/1A	5V/1A	1,2,3,4	-	-	√	-	-	-	-	QFN16	
IP5219	5V/2.4A	5V/2A	1,2,3,4	√	-	√	-	-	-	-	QFN24	
IP5310	5V/3.1A	5V/2.6A	1,2,3,4	√	√	√	-	-	-	-	QFN32	
IP5506	5V/2.4A	5V/2A	Nixie Tube	-	-	-	-	-	-	-	ESOP16	
IP5508	5V/2.4A	5V/2A	Nixie Tube	-	√	-	-	-	-	-	QFN32	
IP5320	5V/3.1A	5V/2.6A	Nixie Tube	√	√	√	-	-	-	-	QFN28	
IP5330	5V/3.1A	5V/2.6A	Nixie Tube	-	√	√	-	-	-	-	QFN32	
IP5328P	20W	18W	1,2,3,4	√	√	√	√	√	-	-	QFN40	
IP5353	22.5W	18W	4	√	√	√	√	√	√	-	QFN32	
IP5355	22.5W	18W	4	√	√	double	√	√	√	-	QFN32	
IP5356	22.5W	18W	Nixie Tube	√	√	double	√	√	√	-	QFN40	PIN2PIN
IP5356H	22.5W	18W	Nixie Tube	√	√	double	√	√	√	-	QFN40	
IP5356M	22.5W	18W	Nixie Tube	√	√	double	√	√	√	-	QFN40	
IP5358	22.5W	18W	Nixie Tube	-	√	√	√	√	√	-	QFN48	
IP5561	22.5W	18W	Nixie Tube	-	√	√	√	√	√	-	QFN48	
IP5568	22.5W	18W	Nixie Tube	-	√	√	√	√	√	-	QFN64	
IP5568U	22.5W	18W	Nixie Tube	-	√	√	√	√	√	-	QFN64	
IP5385	65W	65W	Nixie Tube	√	√	double	√	√	√	√	QFN48	
IP5386	45W	45W	Nixie Tube	√	√	double	√	√	√	-	QFN48	
IP5389	100W	100W	Nixie Tube	√	√	double	√	√	√	-	QFN64	
IP5389H	100W	100W	Nixie Tube	√	√	double	√	√	√	-	QFN64	

## 7. PIN Configuration and Functions

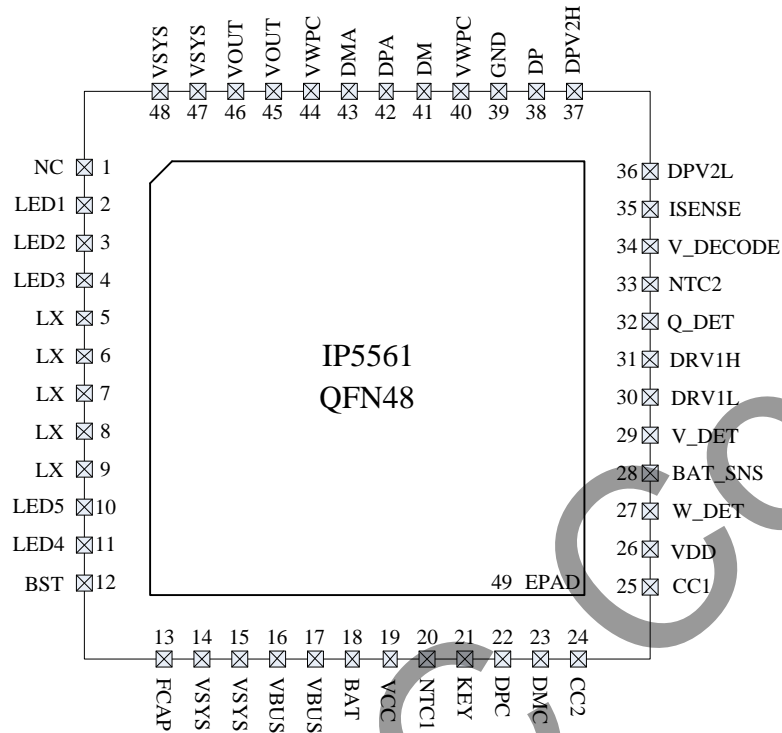


Figure 2 IP5561 48-Pin Top View

### 7.1. IP5561 Pin Functions

Pin Num	Pin Name	DESCRIPTION
1	NC	NC
2	LED1	Battery level display drive PIN LED1
3	LED2	Battery level display drive PIN LED2
4	LED3	Battery level display drive PIN LED3
5、6、7、8、9	LX	DCDC switch node, connect to inductor
10	LED5	Battery level display drive PIN LED5
11	LED4	Battery level display drive PIN LED4
12	BST	Internal high voltage drive, serial capacitor to LX
13	FCAP	Capacity external setting PIN
14、15、47、48	VSYS	Public Node of system power input and output
16、17	VBUS	USB typec port power PIN
18	BAT	Battery supply PIN
19	VCC	3.3V Voltage output PIN
20	NTC1	NTC1 PIN



21	KEY	KEY detect PIN
22	DPC	VBUS port DP PIN
23	DMC	VBUS port DM PIN
24	CC2	VBUS port CC2 PIN
25	CC1	VBUS port CC1 PIN
26	VDD	Wireless charging digital circuit power PIN
27	W_DET	Wireless charge load signal detection PIN
28	BAT_SNS	Battery voltage sampling PIN
29	V_DET	Coil voltage detection PIN
30	DRV1L	DRV1 lower tube driver PIN
31	DRV1H	DRV1 upper tube driver PIN
32	Q_DET	Q Quantity detection PIN
33	NTC2	NTC2/display drive PIN
34	V_DECODE	Voltage decoding input PIN
35	ISENSE	Current sampling input PIN
36	DPV2L	DRV2 lower tube driver PIN
37	DPV2H	DRV2 upper tube drive PIN
38	DP	Wireless charging DP PIN
39	GND	System and power ground
40	VWPC	Wireless charging power supply PIN
41	DM	Wireless charging DM PIN
42	DPA	VOUT port DP PIN
43	DMA	VOUT port DM PIN
44	VWPC	Wireless charging power supply PIN
45、46	VOUT	VOUT output port power PIN
49(EPAD)	GND	System and power ground

## 8. Functional Block Diagram

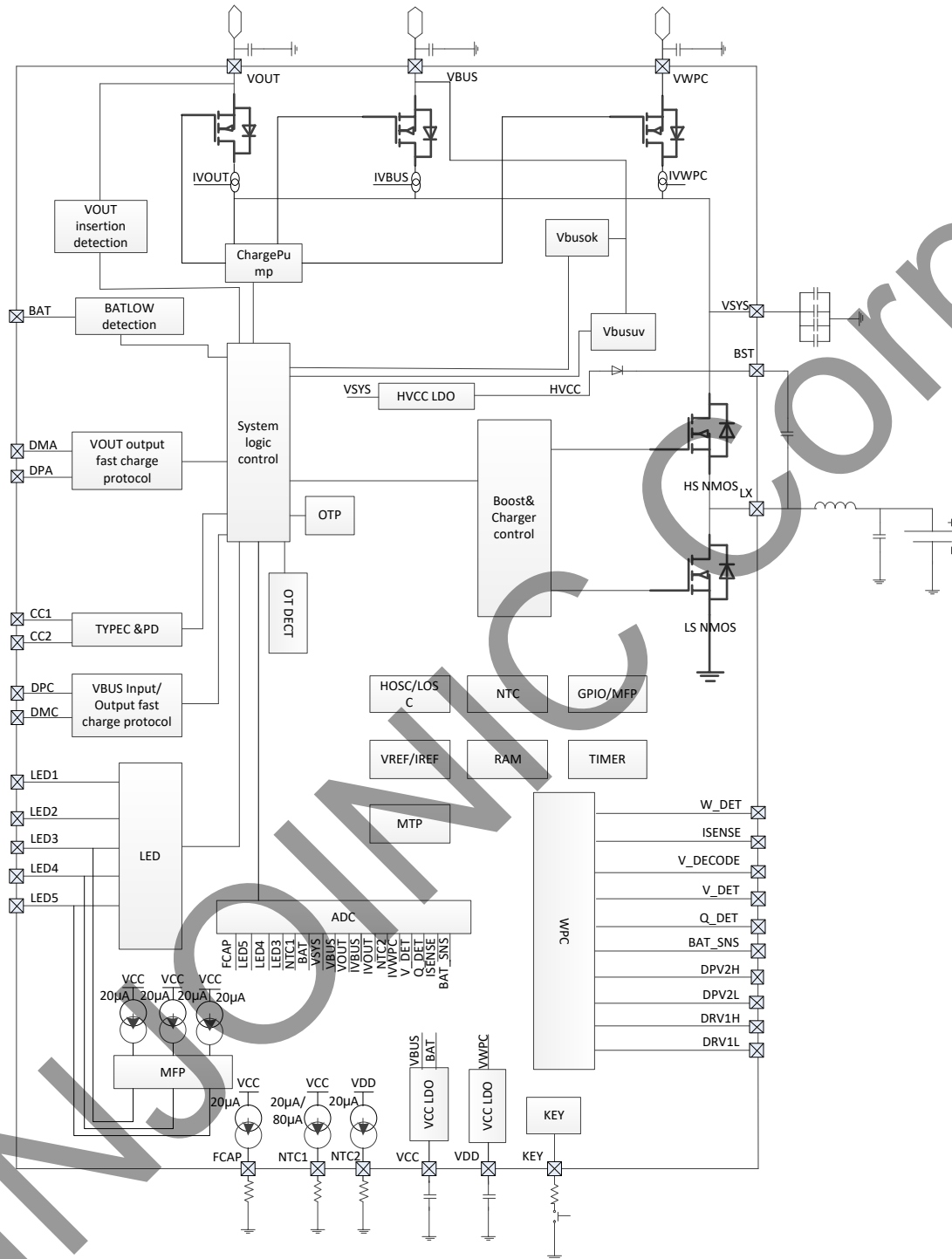


Figure 3 Functional Block Diagram

## 9. Absolute Maximum Ratings

Parameters	Symbol	Value	Unit
Input Voltage Range	$V_{IN}, V_{BUS}$	-0.3 ~ 16	V
Junction Temperature Range	$T_J$	-40 ~ 150	°C
Storage Temperature Range	$T_{stg}$	-60 ~ 150	°C
Thermal Resistance (Junction to Ambient)	$\theta_{JA}$	35	°C / W
ESD (Human Body Model)	ESD	4	KV

\*Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device.

Exposure to Absolute Maximum Rated conditions for extended periods may affect device reliability.

\*Voltages are referenced to GND unless otherwise noted.

## 10. Recommended Operating Conditions

Parameter	Symbol	Min.	Typ.	Max.	Unit
Input Voltage	$V_{BUS}$	4.5	5/9/12	14.0	V
Battery Voltage	$V_{bat}$	3.0	3.7	4.4	V

\*Devices' performance cannot be guaranteed when working beyond those Recommended Operating Conditions.

## 11. Electrical Characteristics

Unless otherwise specified, TA=25°C, L=2.2uH, VBAT=3.8V

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
<b>Charging System</b>						
Input voltage	V <sub>BUS</sub>		4.5	5/9/12	14.0	V
Input Over Voltage	V <sub>BUS</sub>		14.0	14.5	15.0	V
Constant Charge Voltage	V <sub>TRGT</sub>	V <sub>SET</sub> =4.20V	4.18	4.22	4.25	V
		V <sub>SET</sub> =4.30V	4.28	4.32	4.35	V
		V <sub>SET</sub> =4.35V	4.33	4.37	4.39	V
		V <sub>SET</sub> =4.40V	4.38	4.42	4.45	V
		V <sub>BUS</sub> =5V	2.5	2.9	3.3	A
		V <sub>BUS</sub> >=9V	1.7	2.0	2.3	A
Trickle Charge Current	I <sub>TRKL</sub>	V <sub>BUS</sub> =5V, V <sub>BAT</sub> =2.0V	20	50	100	mA
		V <sub>BUS</sub> =5V, V <sub>BAT</sub> <2.5V	50	200	450	mA
Trickle Charge Stop Voltage	V <sub>TRKL</sub>		2.9	3.0	3.1	V
Charge Stop Current	I <sub>STOP</sub>	battery current	250	400	550	mA
Recharge Voltage Threshold	V <sub>RCH</sub>		4.05	4.10	4.15	V
Charge Safety Time	T <sub>END</sub>		20	24	27	Hour
<b>Boost System</b>						
Battery operation voltage	V <sub>BAT</sub>		3.0		4.5	V
DC output voltage	QC2.0 V <sub>OUT</sub>	V <sub>OUT</sub> =5V@1A	4.95	5.12	5.23	V
		V <sub>OUT</sub> =9V@1A	8.70	9.00	9.30	V
		V <sub>OUT</sub> =12V@1A	11.60	12.00	12.40	V
	QC3.0 V <sub>OUT</sub>	@1A	4.95		12.45	V
	QC3.0 Step			200		mV
Output voltage ripple	ΔV <sub>OUT</sub>	V <sub>BAT</sub> =3.7V, V <sub>OUT</sub> =5.0V, fs=350kHz		100		mV
		V <sub>BAT</sub> =3.7V, V <sub>OUT</sub> =9.0V, fs=350kHz		150		mV

		$V_{BAT}=3.7V, V_{OUT}=12V, f_s=350kHz$		200		mV
Boost output current	$I_{out}$	$V_{OUT}=5V$		3.1		A
		$V_{OUT}=9V$		2.22		A
		$V_{OUT}=12V$		1.67		A
Boost efficiency	$\eta_{out}$	$V_{BAT}=3.7V, V_{OUT}=5V, I_{OUT}=2A$		93		%
		$V_{BAT}=3.7V, V_{OUT}=9V, I_{OUT}=2A$		92		%
		$V_{BAT}=3.7V, V_{OUT}=12V, I_{OUT}=1.5A$		91		%
Boost overcurrent shut down threshold	$I_{shut}$	$V_{BAT}=3.7V, V_{OUT}=5V$	3.4	4.0	4.4	A
		$V_{BAT}=3.7V, V_{OUT}=9V$	2.25	2.60	2.90	A
		$V_{BAT}=3.7V, V_{OUT}=12V$	1.7	1.9	2.2	A
Output light load shutdown current	$I_{LOAD}$	$V_{BAT}=3.7V$	30	60	100	mA
Load overcurrent detect time	$T_{UVD}$	Duration of output voltage under 4.2V,		30		ms
Load short circuit detect time	$T_{OCD}$	Duration of output current above 4.4A	150		200	$\mu s$
<b>Control System</b>						
Switch frequency	$f_s$	Discharge switch frequency	350	400	450	kHz
		Charge switch frequency	630	680	730	kHz
NMOS on resistance	$r_{DSON}$	Upper NMOS		9	11	m $\Omega$
NMOS on resistance		Lower NMOS		9	11	m $\Omega$
VCC output voltage	$V_{CC}$	$V_{BAT}=3.7V$		3.3		V
VDD output voltage	$V_{DD}$	$V_{WPC}=5V$		4.8		V
Battery port standby current	$I_{STB1}$	$V_{BUS}=0V, V_{BAT}=3.7V,$ average current		80	200	$\mu A$
	$I_{STB2}$	Wireless charge wakes up automatically, $V_{BUS}=0V, V_{BAT}=3.7V,$ average current		150	300	$\mu A$
VCC output current	$I_{VCC LDO}$	$V_{BAT}=3.7V$	40	50	60	mA
VDD output current	$I_{VDD LDO}$	$V_{WPC}=5V$	40	50	60	mA
LED display driving current	$I_{LED1}$	Voltage decrease 10%		3		mA
	$I_{LED2}$					

	$I_{LED3}$					
Total load Light load shut down detect time	$T1_{load}$	The load current is consistently less than 60mA	25	32	44	s
Output port light load shut down detect time	$T2_{load}$	Between VSN and VOUT1(VOUT2 and VBUS) continued less than 1.8mV	14	16	18	s
Short press on key wake up time	$T_{OnDebounce}$		60	100	200	ms
Thermal shut down temperature	$T_{OTP}$	Rising temperature	130	140	150	°C
Thermal shut down hysteresis	$\Delta T_{OTP}$			40		°C

## 12. Function Description

### 12.1. Low power lock out and activation

When the IP5561 is connected to the battery for the first time, the chip is locked, and the lowest point of the power lamp or the digit of the digital tube flashes five times; In the non-charging state, if the battery voltage is too low to trigger a low-power shutdown, the IP5561 will enter the locked state.

In order to reduce static power consumption, the IP5561 does not support the phone insertion detection function when the chip is locked, nor can it be activated by pressing a button. At this time, the key action cannot activate the boost output, and the lowest level of the battery light or the digit of the digital tube flashes five times to prompt.

When the chip is in the locked state, the chip function can be activated by charging.

### 12.2. Charge

IP5561 integrated trickle, constant current, constant voltage charge management system. IP5561 adopt 680khz synchronous switching charging technology to support different charging voltages.

When the battery voltage is lower than 3V, trickle charging 200mA charging current is applied.

When the battery voltage is higher than 3V, enters constant current charging stage, the maximum charging current at battery port is 5.0A.

When the battery voltage is near the preset battery voltage, enters constant voltage charging stage.

When the charging current is less than 400mA and battery voltage is near the constant voltage charging stage, the charging process is stopped. When the charging stage is accomplished, once the battery voltage falls under 4.1V, battery charging stage will be restarted.

IP5561 supports charging the battery and phone at the same time, output voltage is 5V.

### 12.3. Boost

IP5561 Integrated a synchronized switch converter which supports high voltage output, providing 3.3V ~ 12V output voltage output, load capacity can be: 5V@3.1A, 9V@2.22A and 12V@1.67A. 400kHz switching frequency. Internal soft start function. In avoid of large rush current causing device failure at start up stage, built-in overcurrent, short circuit, overvoltage and over temperature protection function, make insurance of the stability and reliability of power system.

Boost system output current can be auto-modulated according to the temperature, ensuring the IC is under the preset temperature.

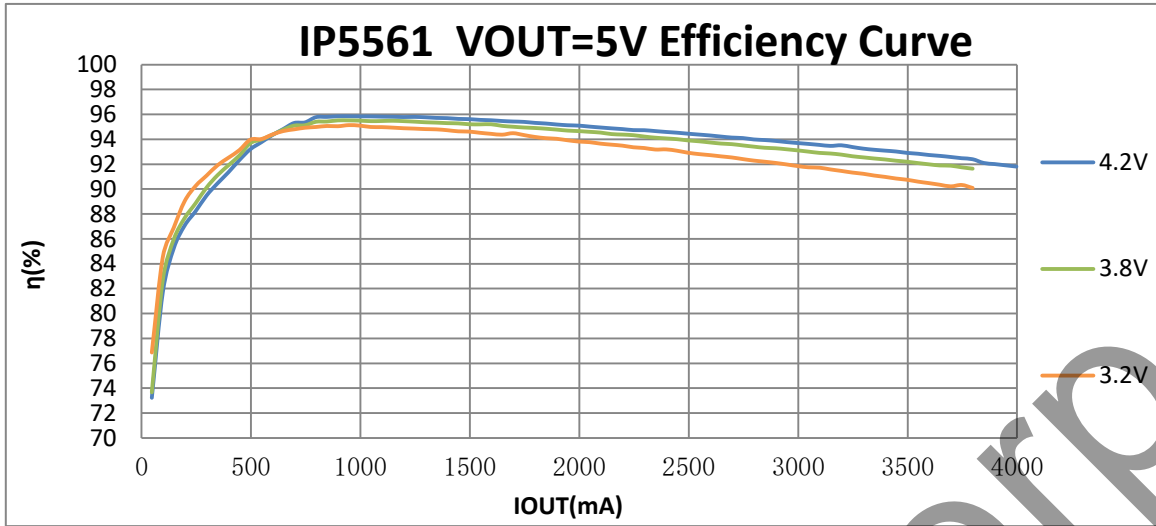


Figure 4 IP5561 VOUT=5V Efficiency Curve

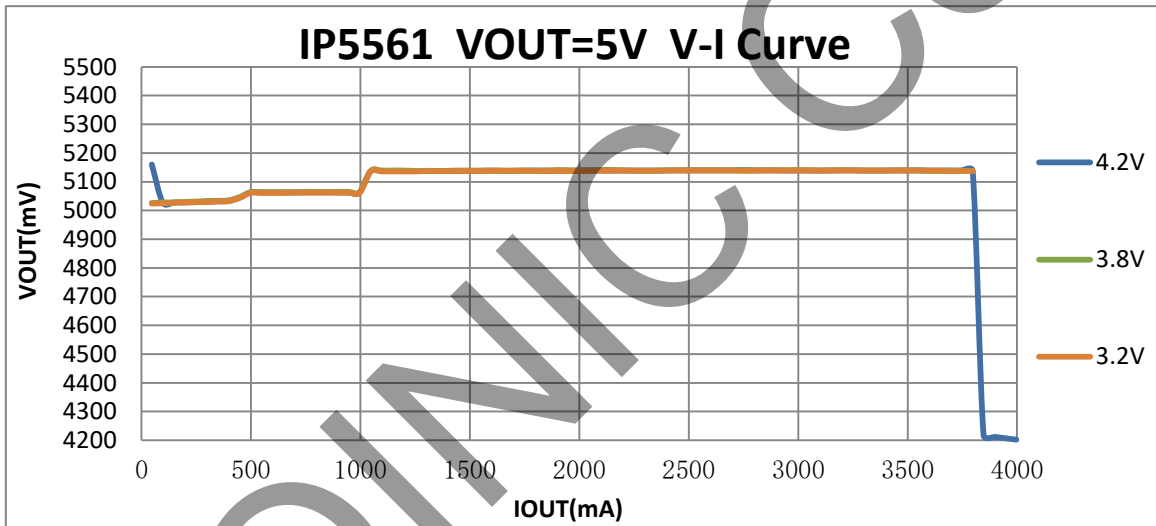


Figure 5 IP5561 VOUT=5V V-I Curve

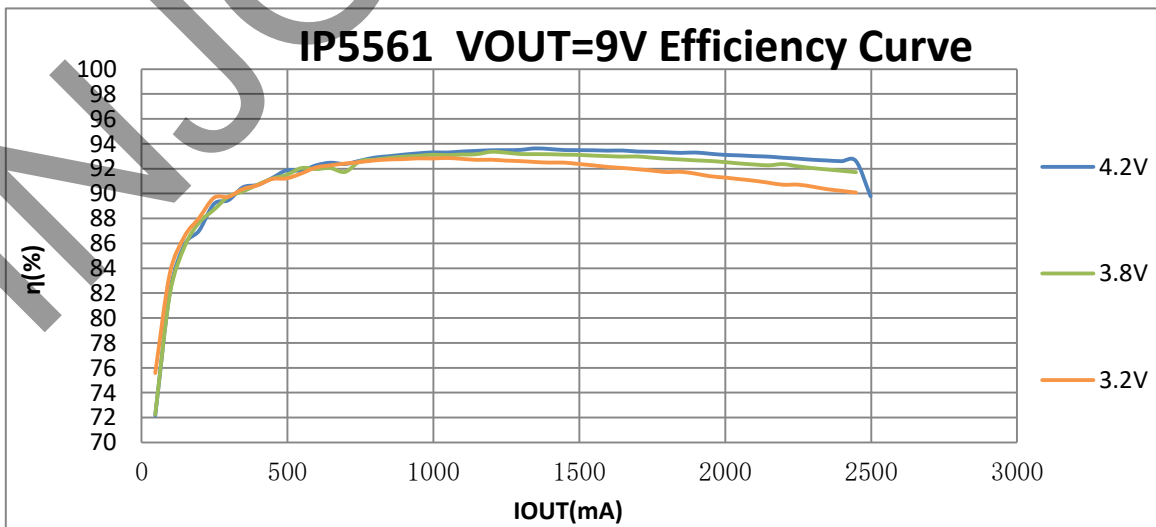


Figure 6 IP5561 VOUT=9V Efficiency Curve



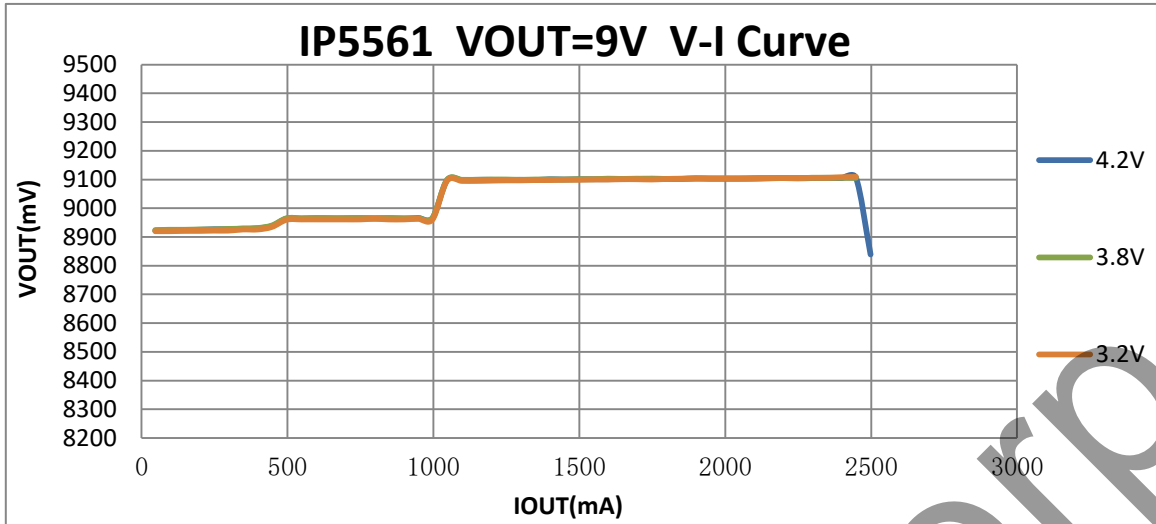


Figure 7 IP5561 VOUT=9V V-I Curve

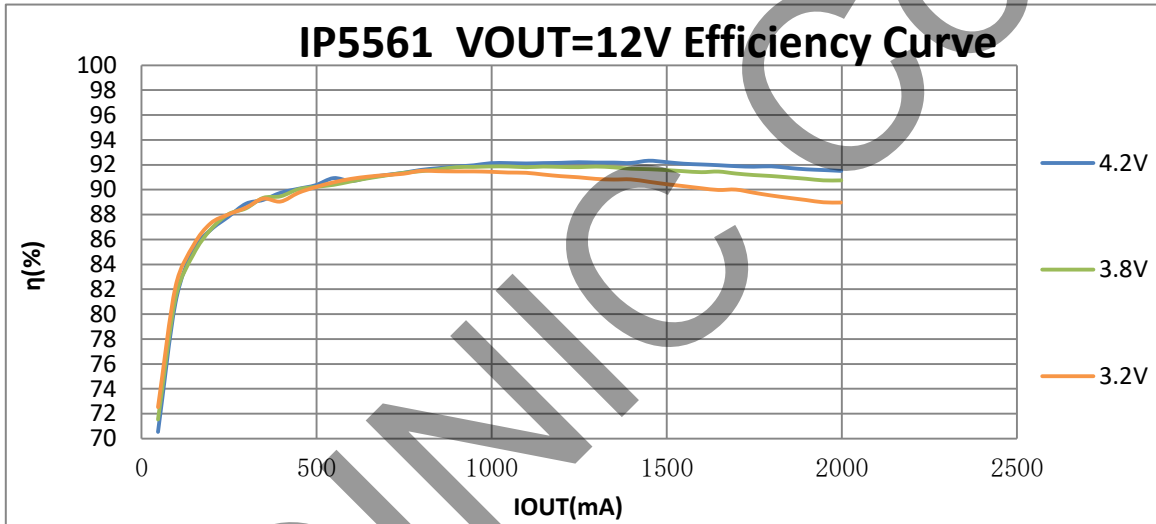


Figure 8 IP5561 VOUT=12V Efficiency Curve

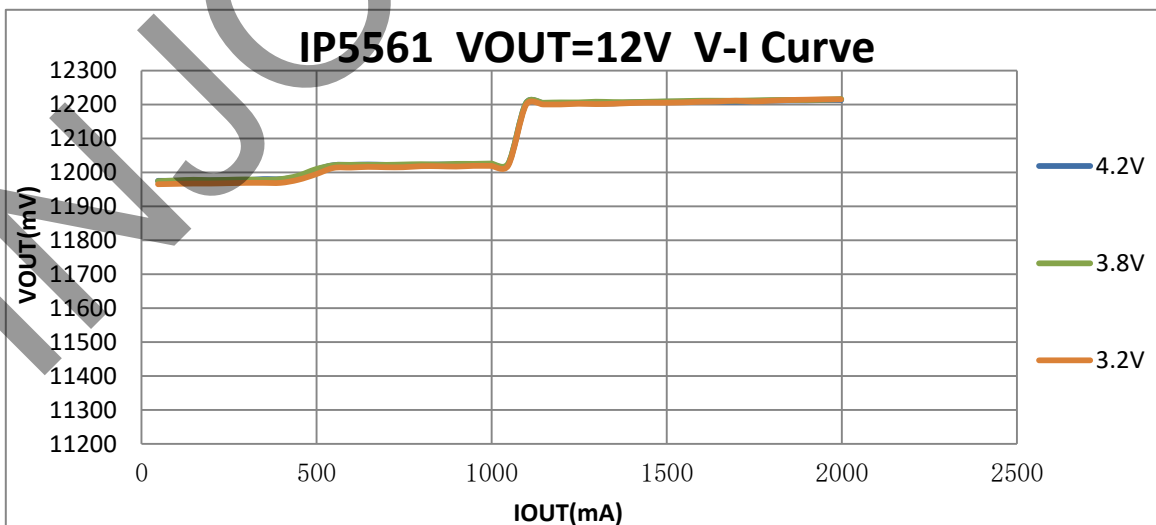


Figure 9 IP5561 VOUT=12V V-I Curve

## 12.4. USB C

IP5561 integrated USB C DRP port, auto-switching the internal pull-up and pull-down circuit on CC1 and CC2 by distinguishing the role of the attached device. Support Try.SRC function, when the attached device is also DRP device, IP5561 will supply power for the opposite device.

When worked as DFP, the output current can be set as 3A; when worked as UFP, the current capability from the opposite device can be detected.

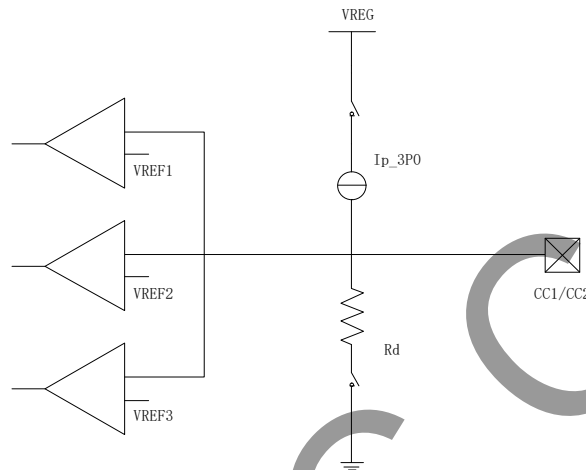


Figure 10 CC internal circuit

Chart 1 Pull-up and pull-down ability

Name	Value
Ip_3P0	330 $\mu$ A
Rd	5.1k $\Omega$

Chart 2 Comparator Threshold of pull-up Ip

	Minimum Voltage	Maximum Voltage	Threshold
Powered cable/adaptor (vRa)	0.00V	0.75V	0.80V
Sink (vRd)	0.85V	2.45V	2.60V
No connect(vOPEN)	2.75V		

Chart 3 Comparator Threshold of Pull-down Resistor Rd

Detection	Min voltage	Max voltage	Threshold
vRa	-0.25V	0.15V	0.20V
vRd-Connect	0.25V	2.04V	
vRd-USB	0.25V	0.61V	0.66V
vRd-1.5	0.70V	1.16V	1.23V
vRd-3.0	1.31V	2.04V	

Figure 4-36 DRP Timing

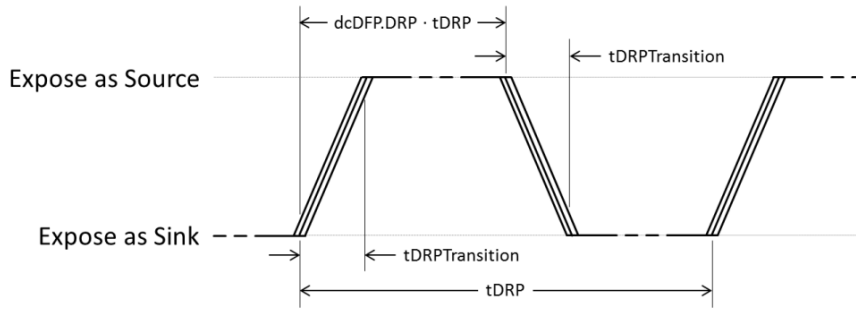


Figure 11 USB C detects cycle

Chart 4 USB C detects cycle

	Minimum	Maximum	Description
tDRP	50ms	100ms	The period a DRP shall complete a Source to Sink and back advertisement
dcSRC.DRP	30%	70%	The percent of time that a DRP shall advertise Source during tDRP
tDRPTransition	0ms	1ms	The time a DRP shall complete transitions between Source and Sink roles during role resolution
tDRPTry	75ms	150ms	Wait time associated with the Try.SRC state
tDRPTryWait	400ms	800ms	Wait time associated with the Try.SNK state

**Figure 4-16 Connection State Diagram: DRP with Accessory and Try.SRC Support**

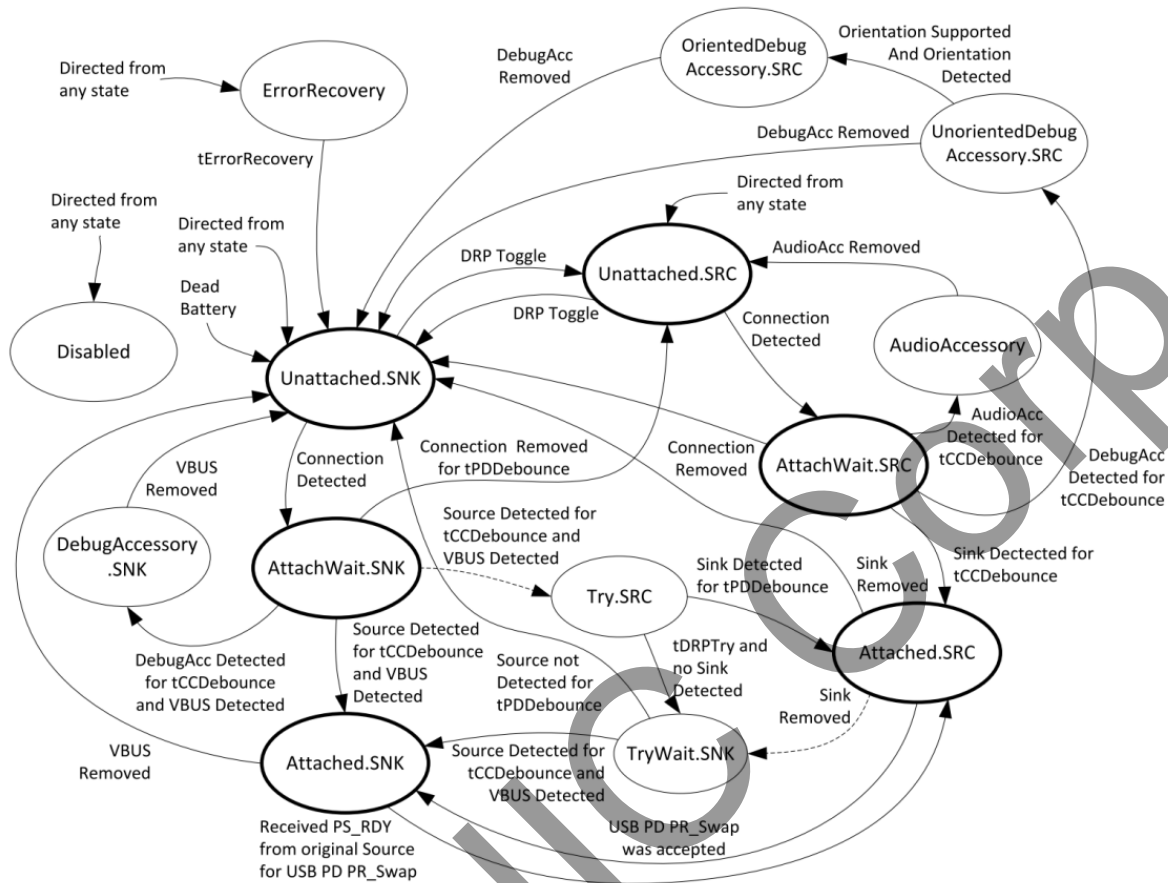


Figure 12 USB C detects state transition

## 12.5. USB C PD

IP5561 integrated USB C Power Delivery PD2.0/PD3.0 / PPS protocol, integrate physical (PHY) layer for data transmitting/receiving across the cc wire, hardware biphas mark coding (BMC) module and hardware CRC protect the data integrity.

Support PD2.0 / PD3.0 bi-directional input/output and PPS output protocol. Input and output voltage support 5V、9V、12V. Output source cap: 5V@3A、9V@2.22A、12V @1.67A、PPS 3.3~11V@2A output voltage adjustable with 20mV / step. Support up to 20W power level.

## 12.6. Fast Charge Protocol

IP5561 support multi fast charge protocols: PD2.0 / PD3.0 / PPS、QC2.0 / QC3.0、FCP、AFC、SCP、Apple、Samsung.

Input QC2.0/QC3.0 protocol is not support for charging the power bank. External fast charging protocol IC is not supported.

Input fast charge protocol of FCP、AFC are supported for charging the power bank.

If the power bank is to charge for the phone, when IP5561 enter discharge mode, it will detect the fast charge type and request on DP, DM, which support fast charge for devices of QC2.0/QC3.0、FCP、AFC、

SCP、 and Apple 2.4A mode, Samsung 2.0A mode and BC1.2 1.0A mode.

For Apple 2.4A mode: DP=DM=2.7V

For Samsung 2.0A mode: DP=DM=1.2V

For BC1.2 1.0A mode: DP short to DM

Under BC1.2 mode, when the DP voltage is detected in the range of 0.325V ~ 2V for 1.25s, fast charge will be initially determined, then the short status between DP and DM will be disconnected, and DM pull-down 20kΩ to GND at the same time. After which, if in the following 2ms the DP voltage is in range of 2V ~ 0.325V and DM lower than 0.325V, fast charge handshake is accomplished successfully. Then QC2.0/QC3.0 device can request for desired voltage according to the QC standards. Any time DP lower than 0.325V will force to exit the fast charge mode, the output voltage will fall back to default 5V.

Chart 5 QC2.0/QC3.0 output voltage request rule

DP	DM	Result
0.6V	GND	5V
3.3V	0.6V	9V
0.6V	0.6V	12V
0.6V	3.3V	Continuous Mode
3.3V	3.3V	sustain

Continuous mode is supported by QC3.0, voltage can be adjusted by 200mV / step according to QC3.0 request under the continues mode.

Chart 6 Fast charging protocol supported by each port of IP5561

protocols	VOUT output	VBUS output	VBUS input
QC2.0	√	√	-
QC3.0	√	√	-
AFC	√	√	√
FCP	√	√	√
SCP	√	√	-
PD2.0	-	√	√
PD3.0	-	√	√
PPS	-	√	-

Supported : √

Not Supported :-

## 12.7. Charge and Discharge Path Management

### Standby:

If VBUS is attached, IP5561 will start the charging process directly.

If USB C UFP device is attached on VBUS or sink device is attached on VOUT port, IP5561 will start discharge function automatically.

If key is pressed, the VOUT and VBUS port will open only when load is detected on the according port, or the output on these port will be closed.

## Discharge:

In the case of no key action, only the output path of the output port plugged in the electrical equipment will be opened; the output path of the output port not connected to the equipment will not be opened. When the output current of the opened output port is less than about 60mA, it will automatically close after a period of time.

Any port of VOUT and VBUS can support the output fast charging protocol. However, since this application is a single inductance application, it can only support one voltage output, so it can only support the fast charging output when only one output port is open. When two or three outlets are used at the same time, the quick charge function will be automatically turned off.

According to the connection shown in the "typical application diagram", when any output port has entered the fast charging output mode, when the other output port is plugged in with electrical equipment, all the output ports will be closed first, the high-voltage fast charging function will be closed, and then the output ports with equipment will be opened. In this case, all the output ports only support the charging of apple, Samsung and bc1.2 modes. When the number of electrical equipment is reduced to only one, after 16 seconds, all output ports will be closed first, the high-voltage fast charging function will be turned on, and then the output port of the last electrical equipment will be turned on, so as to reactivate the equipment to request fast charging. When only one output port is open and the total output current is less than about 60mA for about 32S, the output port and discharge function will be closed and the standby mode will be entered.

When the wireless charge TX, VOUT, VBUS three outputs have any two or more outputs at the same time, output voltage is only 5V.

When only one port of wireless charging TX, VOUT, and VBUS is opened, the fast charging function is enabled.

When only the wireless charging TX charges the device and VOUT and VBUS are turned off, the wireless charging TX can transmit 10W/15W power.

## Charging:

VBUS port can be charged by inserting the power supply.

In the single charging mode, the fast charging mode of the power supply will be automatically identified, and the appropriate charging voltage and current will be automatically matched.

When only VBUS and wireless charging TX are working, and the VBUS applies for high voltage, the wireless charging TX can transmit 15W of power.

## Charging and discharging at the Same Time:

When the charging power supply and the electrical equipment are plugged in at the same time, the charging and discharging mode will be automatically entered. In this mode, the chip will automatically turn off the internal fast charge input request. When the vsys voltage is only 5V, turn on the discharge path to supply power to the electrical equipment; if the vsys voltage is greater than 7.0V, for safety reasons, the discharge path will not be turned on.

In the process of charging and discharging, if the charging power is unplugged, IP5561 will turn off the charging function and restart the discharging function to supply power to the electric equipment. For the sake of safety, and in order to be able to reactivate the mobile phone to request fast charging, the voltage will drop to 0V for a period of time during the conversion process.

In the process of charging and discharging, if the electric equipment is unplugged, or the electric

equipment is full and stops pumping for 16s, the corresponding discharge path will be automatically closed. When the discharge paths are closed and the state returns to single charging mode, the charging undervoltage loop will be reduced, and the fast charging will be automatically reactivated to accelerate the charging of mobile power supply.

## 12.8. Automatic detection of mobile phone

### Auto detection on sink device / phone attachment:

IP5561 support auto detection on sink device/phone attachment/plug in, once the attachment is detected, the boost will be turned on charging the sink device / phone, so non-key solution are supported.

### Auto detection on sink device / phone fully charged:

IP5561 measures the output current of each port through the on-chip ADC. When the output current of a single port is less than about 60mA and lasts for about 16s, the output port will be closed. When the total current is less than about 60mA for about 32s, it is considered that all output cell phones are full or unplugged, and the boost output will be automatically turned off.

## 12.9. KEY / nixie tube selection

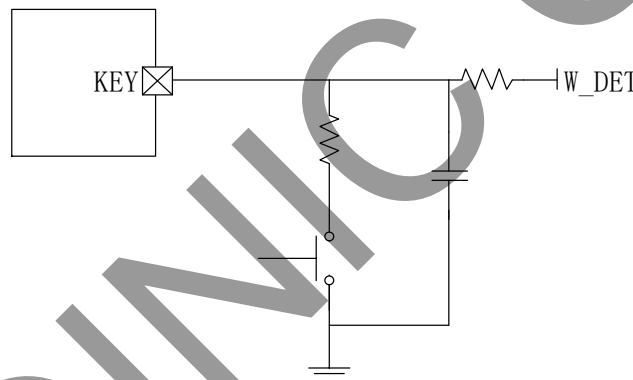


Figure 13 KEY circuit

Key circuit is illustrated in Figure 13, which can recognize short press or long press operation.

- Short press : pressed time in range of 60ms~2s: turn on the battery level display LED and boost output.
- No response on press time less than 30ms.
- Two short press in 1s: turn off boost output, battery level display LED.

## 12.10. Fast Charge state indication

LED4 of IP5561\_LL series IC is used for indication for the present fast charge mode, either in fast charging or discharging mode, when the system enters fast charge mode and in non-5V mode, the light LED will turn on.

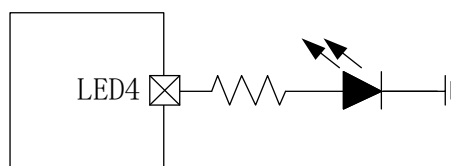


Figure 14 fast charge state indication

## 12.11. Coulombmeter and battery level display

IP5561 has built-in coulombmeter function, which can realize accurate calculation of the remaining battery capacity.

IP5561 supports 4 LED, 2 LED and 1 LED mode automatic selection.

IP5561 supports 88 / 188 nixie tube to display the remaining battery capacity .

### 12.11.1. Battery level display for LED mode

IP5561 4LED、2LED and 1LED battery level display solution, the connection method is as follows.

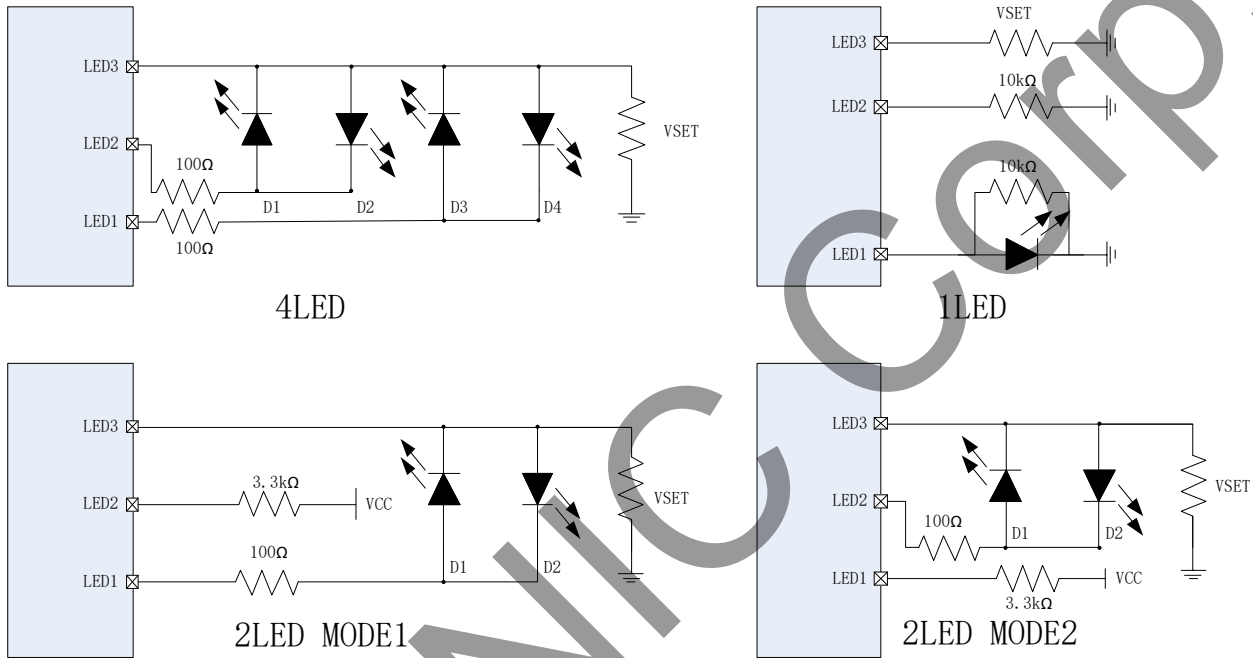


Figure 15 4LED , 2LED, 1LED circuits

Chart 7 4LED display mode During charging

Battery capacity (C) (%)	D1	D2	D3	D4
Fully charged	ON	ON	ON	ON
$75\% \leq C$	ON	ON	ON	0.6Hz Flash
$50\% \leq C < 75\%$	ON	ON	0.6Hz Flash	OFF
$25\% \leq C < 50\%$	ON	0.6Hz Flash	OFF	OFF
$C < 25\%$	0.6Hz Flash	OFF	OFF	OFF

Chart 8 4LED display mode During discharging

Battery capacity (C) (%)	D1	D2	D3	D4
$C \geq 75\%$	ON	ON	ON	ON
$50\% \leq C < 75\%$	ON	ON	ON	OFF



$25\% \leq C < 50\%$	ON	ON	OFF	OFF
$3\% \leq C < 25\%$	ON	OFF	OFF	OFF
$0\% < C < 3\%$	1.2Hz Flash	OFF	OFF	OFF
$C = 0\%$	OFF	OFF	OFF	OFF

Chart 9 2 LED display mode 1 is bi-color LED During charging

Battery capacity (C) (%)	D1	D2
Fully charged	OFF	ON
$66\% \leq C < 100\%$	OFF	0.6Hz Flash
$33\% \leq C < 66\%$	0.6Hz Flash	0.6Hz Flash
$C < 33\%$	0.6Hz Flash	OFF

Chart 10 2 LED display mode 1 is bi-color LED During discharging

Battery capacity (C) (%)	D1	D2
$66\% \leq C < 100\%$	OFF	ON
$33\% \leq C < 66\%$	ON	ON
$C < 33\%$	ON	OFF
$C < 3\%$	1.2Hz Flash	OFF

2 LED mode 2 display:

During charging: D1 LED flash on cycle of 1.6s (0.8s on and 0.8s off), when fully charged, constantly on;

During discharging: D2 LED is constantly on, when voltage lower than 3.2V, flash on cycle of 0.8s (0.4s on and 0.4s off), when voltage is lower than 3.0V, system is power down.

1 LED mode display:

During charging: LED flash on cycle of 1.6s (0.8s on and 0.8s off), when fully charged, constantly on;

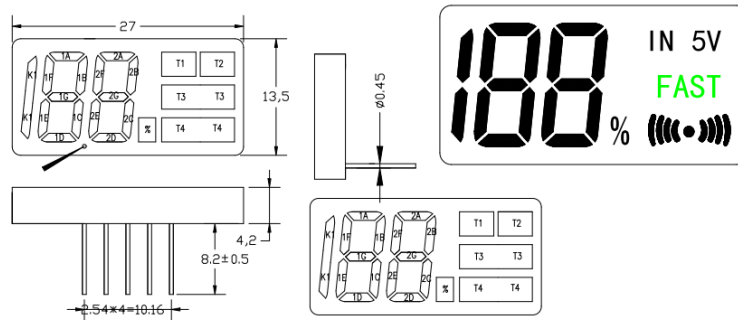
During discharging: LED is constantly on, when voltage lower than 3.2V, flash on cycle of 0.8s (0.4s on and 0.4s off), when voltage is lower than 3.0V, system is power down.

### 12.11.2. 188 nixie tube display mode

Chart 11 The 188 nixie tube model IP5561 supported as below

state	display	
During charging	Not fully charged	0 - 99% 0.5HZ Flash
	Fully charged	constantly on 100%
During discharging	Battery capacity > 5%	5% - 100% constantly on
	Battery capacity < 5%	0 - 5% 1.0Hz Flash
	Wireless charging with load	wireless charging icon is on
	Wireless charging light load	wireless charger icon is off
	Wireless charging abnormal	wireless charger icon flash

5pin 188 nixie tube:



4. 电路图 (Circuit Diagram) :

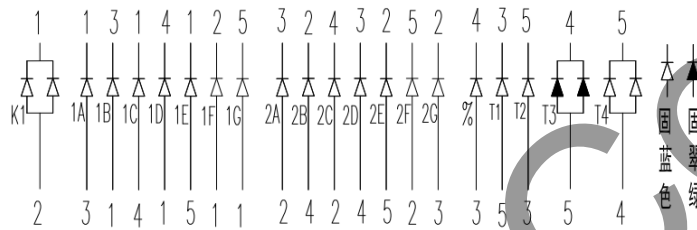


Figure 16 5pin 188 nixie tube circuit

Chart 12 IP5561 Light Drives Drive Pin and Digital Tube Pin Map Relationship

	IP5561 display driver pin	nixie tube pin	note
The sequence mapping relationship between IP5561 display driver pin and nixie tube pin	LED1(2 pin)	1 pin	
	LED2(3 pin)	2 pin	
	LED3(4 pin)	3 pin	
	LED4(11 pin)	4 pin	
	LED5(10 pin)	5 pin	

### 12.11.3. Coulombmeter

IP5561 supports the external resistor setting of the initial capacity of the battery, and uses the integration of the current and time at the port of the battery to manage the remaining capacity of the battery, which can accurately display the current remaining capacity of the battery.

IP5561 external pin sets the initial battery capacity formula: battery capacity =  $R_{FCAP} * 0.448$  (mAH). Up to 60000mah.

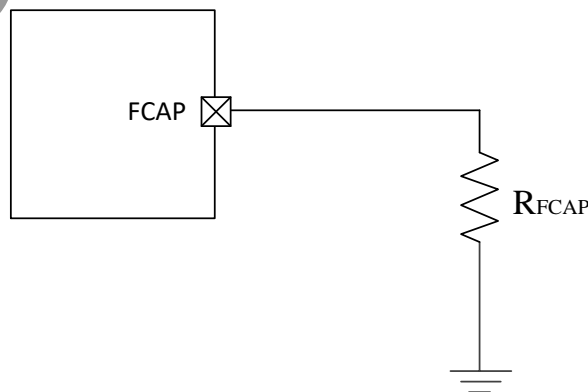


Figure 17 Battery capacity configuration circuit

Chart 13 Typical battery capacity config table

$R_{FCAP}$	battery initial capacity (mAh)= $R_{FCAP} \times 0.448$ (mAh)
11k $\Omega$	5000 mAh
22k $\Omega$	10000 mAh
33k $\Omega$	15000 mAh
44k $\Omega$	20000 mAh
56k $\Omega$	25000 mAh
66.5k $\Omega$	30000 mAh
90k $\Omega$	40000 mAh
110k $\Omega$	50000 mAh
133k $\Omega$	60000 mAh

## 12.12. VSET(Battery voltage selection)

IP5561\_LL series IC support 4.20V, 4.3V, 4.35V and 4.40V batteries for LED3 pin. By setting the type of battery through VSET (LED3) pin, the threshold value of power display, the constant voltage of charging battery and the protection voltage are changed. The Vset resistance values and battery type are shown in the table below.

Chart 14 Battery voltage selection config table

$R_{LED3}$	Battery full voltage selection
NC	4.2V
62k $\Omega$	4.3V
33k $\Omega$	4.35V
10k $\Omega$	4.4V

## 12.13. NTC function

IP5561 integrates TWO NTC function, which can detect battery temperature, NTC1 is used to detect the battery temperature, and NTC2 is used to detect the wireless charging coil temperature. When IP5561 is working, NTC1 pin output current, and generate voltage through external NTC resistance. IC internal detects the voltage of NTC pin to determine the current battery temperature.

\* The 100nF capacitance of NTC must be close to IC PIN.

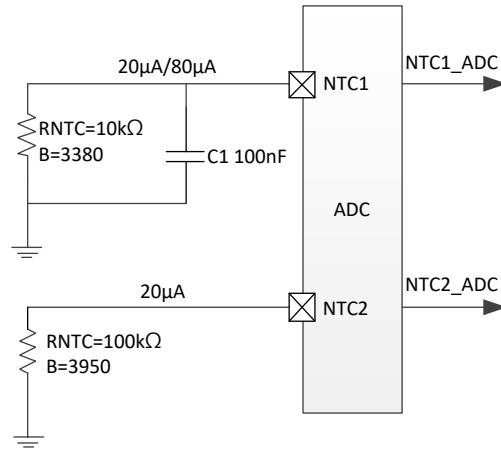


Figure 18 NTC1 circuit

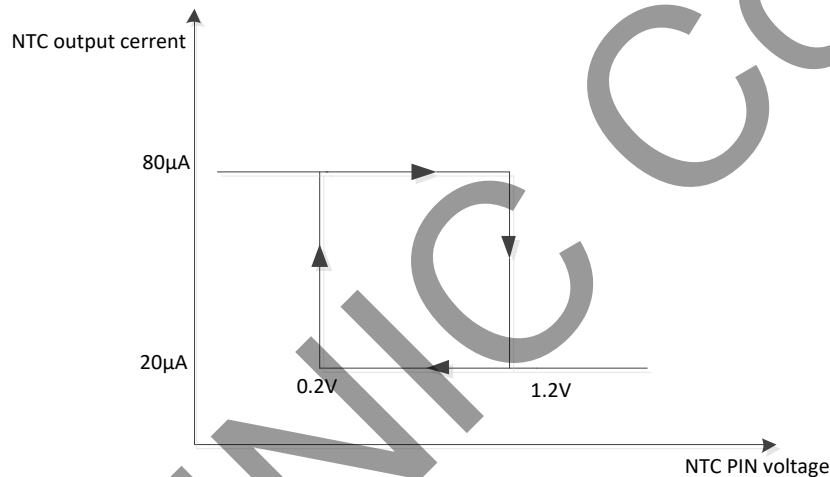


Figure 19 Relationship between NTC1 voltage and output current

In order to distinguish the temperature between high temperature and low temperature, NTC1 emits 80µA current at high temperature and 20µA current at low temperature.

When the NTC1 discharge current is 80µA, if the NTC1 voltage is higher than 1200mV, the current becomes 20µA;

When the NTC1 discharge current is 20µA, if the NTC1 voltage is lower than 200mV, the current changes to 80µA.

In the state of charge:

When the NTC1 voltage is lower than 0.39V, it means the battery temperature is higher than 45°C, the charging is stopped.

When the NTC1 voltage is higher than 0.54V, it means the battery temperature is lower than 0°C, the charging is stopped.

In the state of discharge:

When the NTC1 voltage is lower than 0.24V, it means the battery temperature is higher than 60°C,

the discharging is stopped.

When the NTC1 voltage is higher than 1.38V, it means the battery temperature is lower than  $-20^{\circ}\text{C}$ , the discharging is stopped.

If NTC1 is not required in the application, 10k $\Omega$  resistance shall be connected to the ground at NTC1 pin, and floating or direct grounding is not allowed.

NTC2 is used to detect the temperature of the wireless charging coil. The output current of the NTC2 pin is 20 $\mu\text{A}$ . When the voltage detected by the NTC2 pin is lower than 0.29V, the coil temperature exceeds  $75^{\circ}\text{C}$ , and the wireless charging and discharging will be turned off. When the NTC2 voltage is higher than 0.7V (coil temperature is lower than  $50^{\circ}\text{C}$ ), wireless charge and discharge will be resumed.

## 12.14. Wireless charging

### 12.14.1. H Bridge Drive

The IP5561 has two built-in symmetrical half-bridge driver modules and an external N+PMOS H-bridge. The dead time and drive strength of the driver modules can be software configured to different gears. During EMI EMC testing, the EMI margin can be improved by configuring a lower drive capability, thus saving external RC devices.

The IP5561 uses 20m $\Omega$  sampling resistor for low-side sampling of the H-bridge current, and the RC filter device for the sampled signal should be placed close to the IC to avoid noise interference.

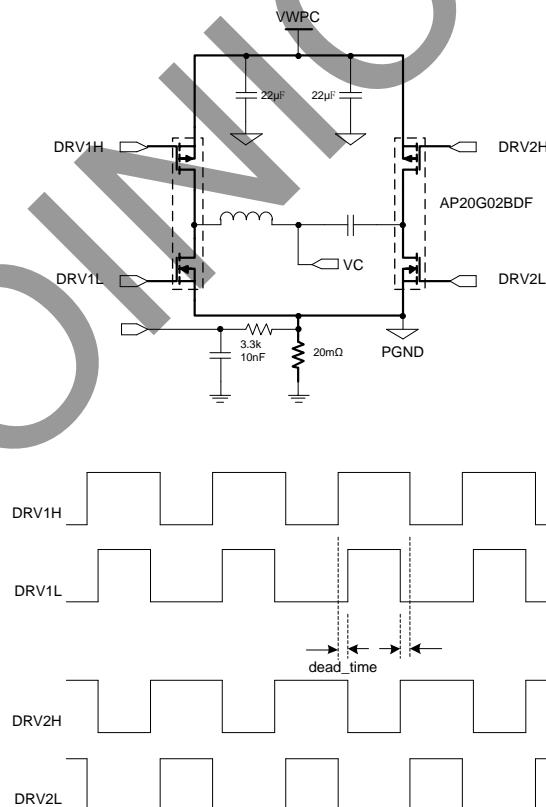


Figure 20 Wireless charging H Bridge

### 12.14.2. ASK communication demodulation/FSK modulation

The IP5561 has a built-in ASK demodulation module. For the ASK modulated signal from the

receiving device, the IP5561 collects the coil voltage and current for ASK signal demodulation and decoding respectively. The system implements the Qi wireless charging protocol based on the ASK decoded data.

IP5561 has built-in FSK modulation function, through FSK modulation, IP5561 can send information to the receiving device to realize PPDE, EPP, MPP and other protocols.

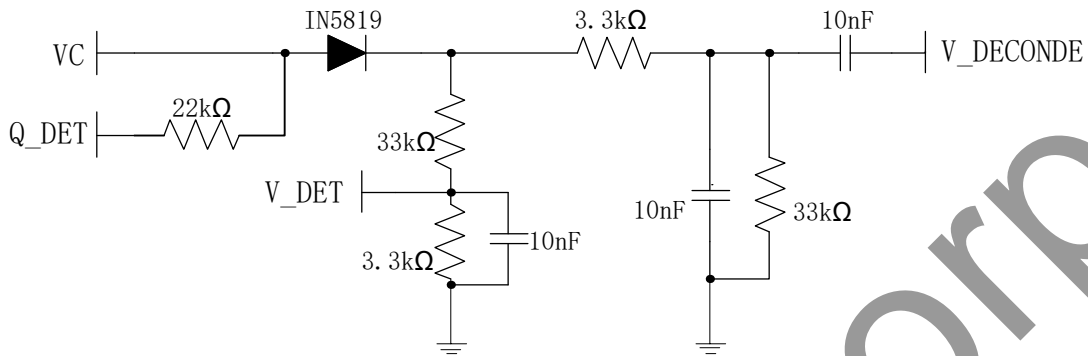


Figure 21 Wireless charging and demodulation circuit

### 12.14.3. Wireless Charging Indicators

The IP5561 supports NTC2 pin time-sharing multiplexing to achieve the LED indicator function, which indicates the wireless charging status by driving the NTC2 output. The corresponding relationship between the LED status and the wireless charging system status is as follows.

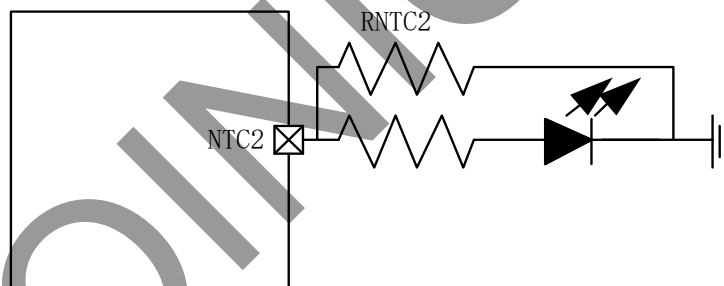


Figure 22 Wireless Charging Indicators

Chart 15 Wireless lamp display

State	NTC2(33PIN)
Power on	Blink three times at 1.0HZ
Wireless charging abnormal	1.0HZ Flash
Charge complete	OFF
Charging	0.5HZ Flash
standby	ON

### 12.14.4. Wireless Charging Automatic Wake Up

IP5561 wireless charging supports automatic detection of mobile phone, mobile phone is placed on the coil immediately wake up from the standby state, open the output to charge the phone, no button

operation, support no button solution.

### 12.14.5. Wireless Charging Sampling Battery Voltage

IP5561 supports wireless charging sampling battery voltage, and the remaining battery power can be displayed through the double window when charging the mobile phone.

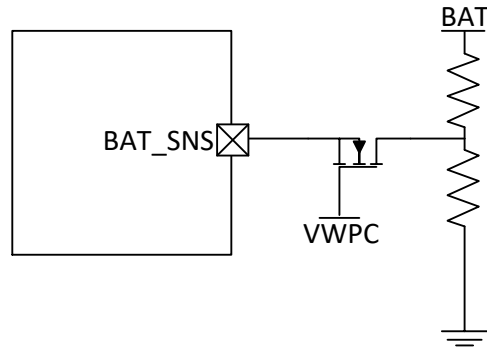


Figure 23 Wireless rechargeable battery voltage sampling circuit

### 12.14.6. FOD threshold setting

IP5561\_LL\_Pxxx series supports the FOD threshold selection through the NTC2 pin and the configuration of different static and dynamic FOD parameters. This series does not support coil temperature detection. Chart 16 shows the resistance  $R_{FOD\_SEL}$  and FOD thresholds.

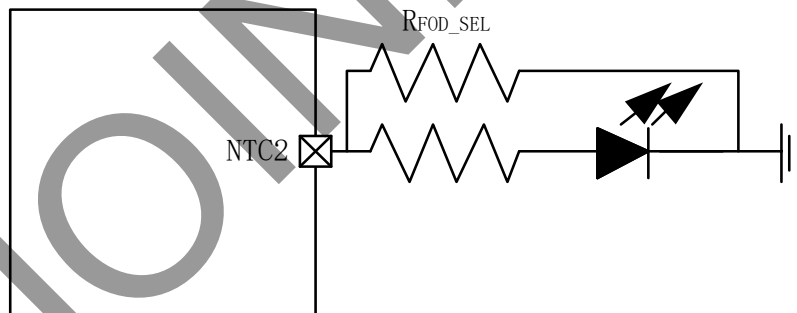


Figure 24 FOD threshold setting

Chart 16 FOD threshold

$R_{FOD\_SEL}$	Static FOD threshold	Dynamic FOD threshold (mW)
0Ω-20kΩ	$R*8+100$	-500
25kΩ-45kΩ	$(R-25)*8+100$	0
50kΩ-70kΩ	$(R-50)*8+100$	500

Non-magnetic default resistance 25 kΩ, magnetic default resistance 39 kΩ.

## 12.15. VCC

VCC is a normally open 3.3V LDO with a load capacity of 50mA.

## 12.16. I2C

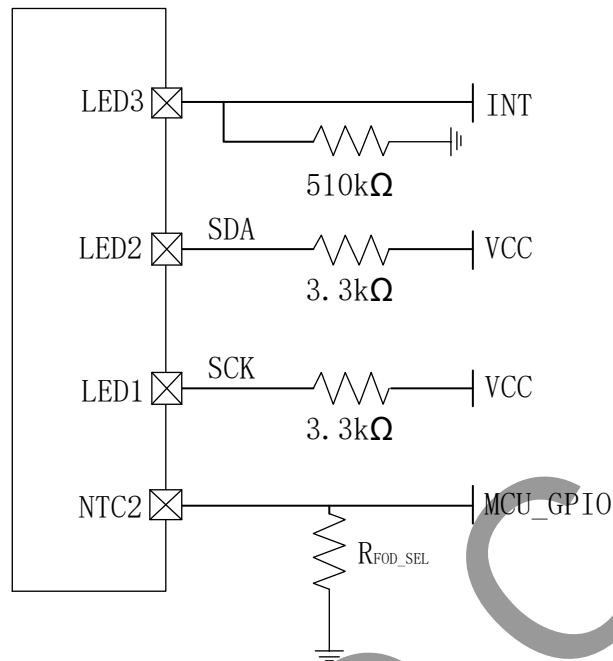


Figure 25 I2C

IP5561\_LL\_PXXX series supports I2C connection. According to the corresponding connection mode, IC will automatically enter or close I2C mode. In I2C mode, the INT signal is in high resistance state in standby mode and high level state in working state, which can be used to wake up MCU. IP5561\_LL\_PXXX series supports MCU to read mobile power related information through I2C, Indicate the wireless charging status through the high and low level status of NTC2, does not support NTC2 Coil temperature detection function, detailed information can refer to IP5561(with reg) data.



## 13. PCB Layout

Here below lists essential precautions that may affect the function and performance on PCB layout, more details will be attached in another document if any.

### 13.1. Location of VOUT / VBUS / VWPC capacitor

IP5561 integrates USB output power path. The 2.2 $\mu$ F capacitor of VOUT / VBUS / VWPC must be close to the IC pin. If the layout allows, the position of the 2.2 $\mu$ F capacitor should be as close as possible to the chip.

At the same time, a 100nF capacitor is placed near the USB connector, and the capacitance is parallel to the USB connector.

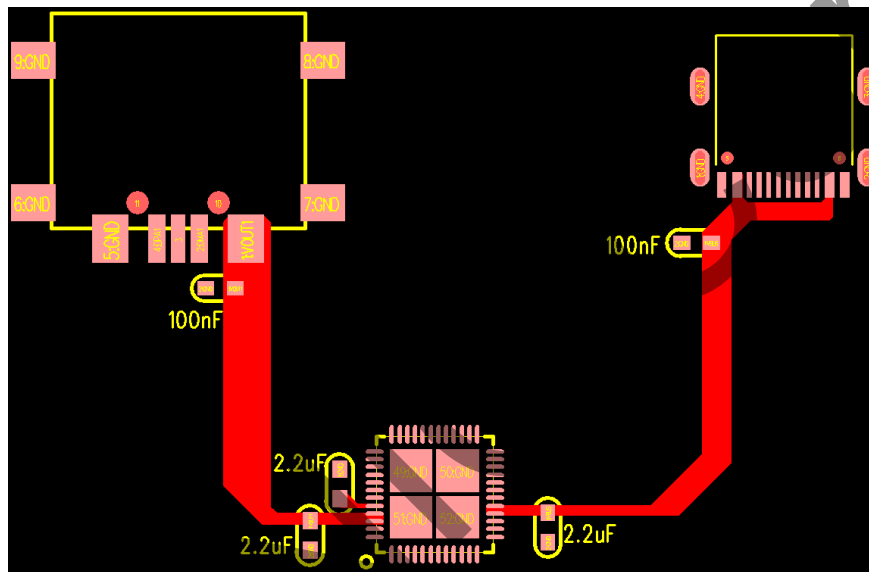


Figure 26 Location of VOUT1 / VOUT2 / VBUS capacitor

### 13.2. Location of VSYS capacitor

The power and current of the chip are relatively large, and the position of the capacitor on the VSYS network will affect the stability of the DCDC. The capacitors on the vsys network need to be as close to the vsys pin and EPAD of the IC as possible, and copper is laid on a large area, and more vias are added to reduce the area of current loop between the capacitors and the IC and reduce parasitic parameters.

VSYS pins are distributed on both sides of the chip, and capacitors need to be placed near the pins on both sides, and the vsys pins on both sides are connected by a wide (no less than 100mil) copper laying on the PCB.

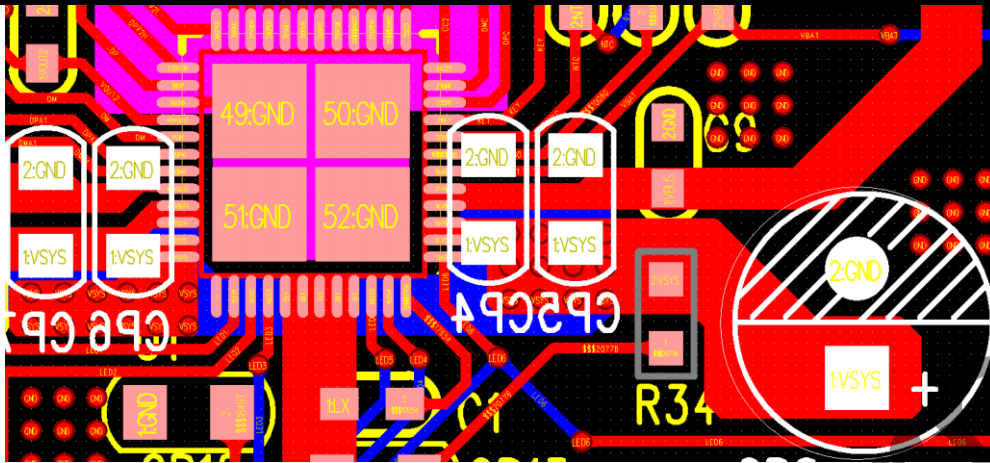


Figure 27 Location of VSYS capacitor

### 13.3. Location of BAT/VCC/VDD/NTC capacitor

The filter capacitors of bat pin and BAT/VCC/VDD/NTC pin should be placed as close as possible to the pin of the chip, and some holes should be drilled near the capacitors GND pin.

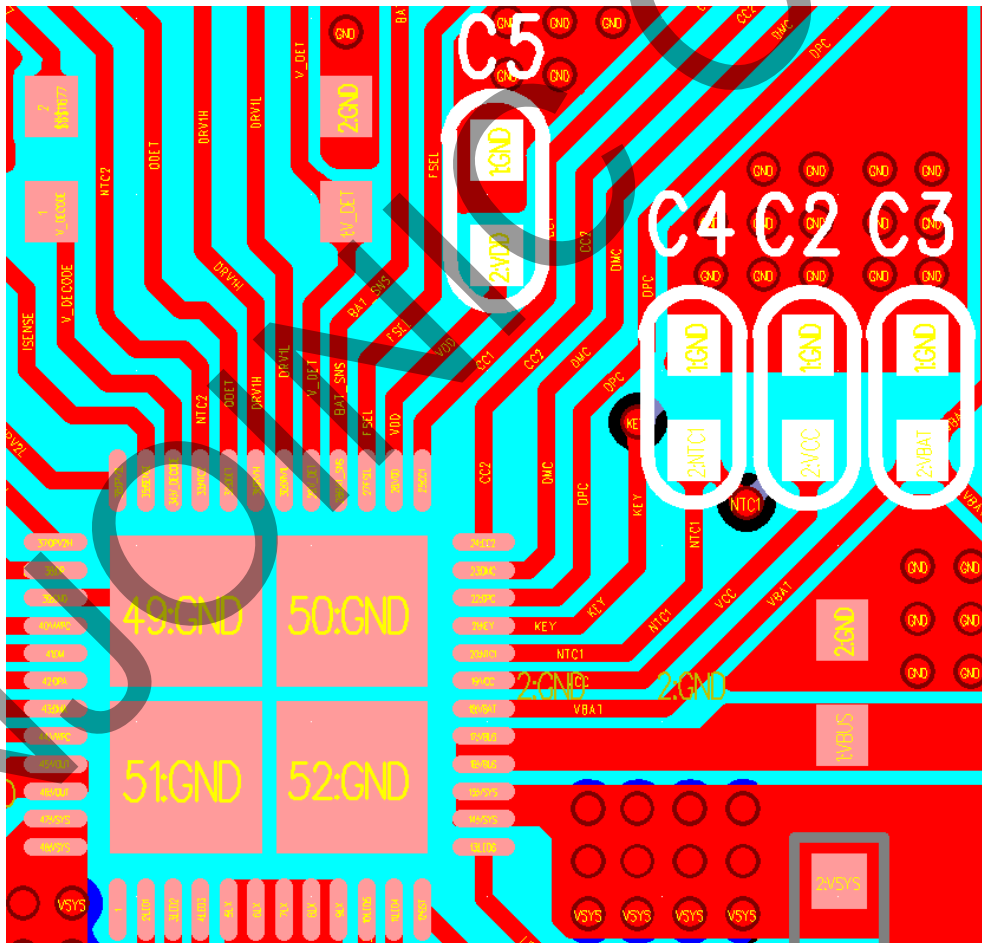


Figure 28 Location of BAT/VCC capacitor

## 13.4. Wireless charging Sampling resistance

IP5561 samples the H-bridge current through the 20mΩ sampling resistance. The ground of the 20mΩ sampling resistance needs to be separately laid with copper to the chip EPAD. The RC filtering circuit of the sampled signal should be placed close to the chip pin, otherwise the wireless charging circuit is prone to noise interference and will not work normally.



Figure 29 Wireless charging sampling resistance wiring

## 14. Typical Application Diagram

Total solution of fast charge power bank is merely realized by passive devices of MOSFET, inductor, capacitor and resistor.

### 14.1. Power bank+TX+LED application

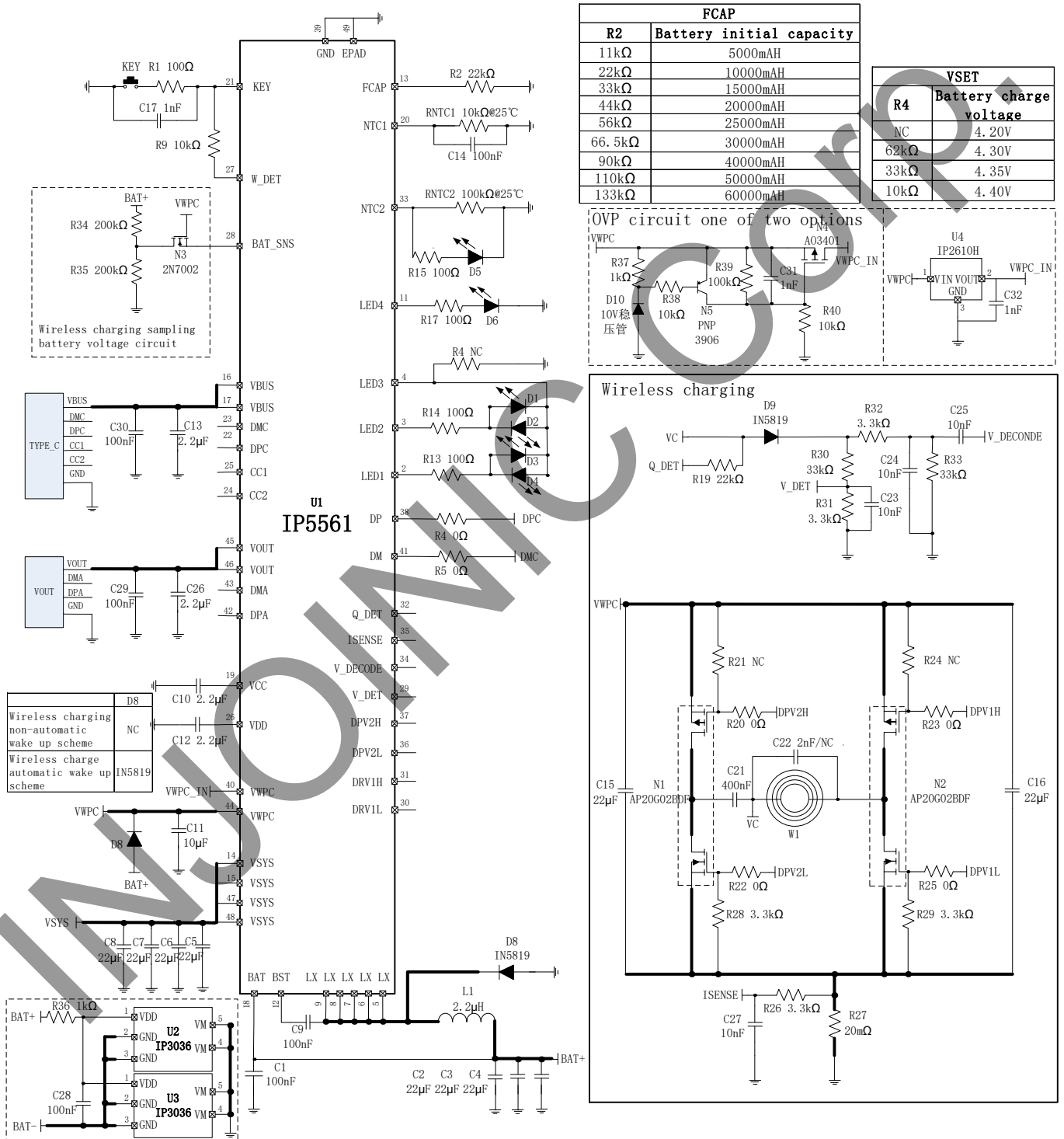


Figure 30 IP5561 LED application circuit

**BOM 表**

No.	Part Name	Type	Location	Num	Note
1	IC	QFN48 IP5561	U1	1	
2	SMT capacitor	0603 100nF 10% 25V	C1 C9 C14 C29 C30	5	
3	SMT capacitor	0805 22μF 10% 16V	C2 C3 C4	3	
4	SMT capacitor	0805 22μF 10% 25V	C5 C6 C7 C8	4	
5	SMT capacitor	0603 2.2μF 10% 25V	C10 C12 C13 C26	4	
6	SMT capacitor	0603 1nF 10% 25V	C17	1	
7	SMT capacitor	0603 10μF 10% 25V	C11	1	
8	SMT capacitor	CAP-5-5 100μF	CP1	1	
9	SMT Schottky	IN5819	D8 D9	2	
10	KEY	SMT 3*6	KEY	1	
11	Inductor	2.2μH 10*10	L1	1	
12	Output USB connector	AF10 8 USB	VOUT	1	
13	USB C connector	USB C connector	TYPE_C	1	
14	SMT resistor	0603 100Ω 1%	R1	1	
15	SMT resistor	0603 22kΩ 1%	R2	1	
16	SMT resistor	0603 10kΩ 1%	R9	1	
17	SMT resistor	0603 0Ω 1%	R4 R5 R17	3	
18	SMT resistor	0603 100Ω 1%	R13 R14 R15 R17	4	
19	SMT LED	0603	D1 D2 D3 D4 D5 D6	6	
20	NTC thermal resistor	10 kΩ@25°C B=3380	RNTC1	1	
21	NTC thermal resistor	100 kΩ@25°C B=3950	RNTC2	1	
22	SMT capacitor	0805 22μF 10% 25V	C15 C16	2	Wireless charging circuit BOM
23	CBB resonant capacitor	400nF 100V	C21	1	
24	SMT capacitor	0603 2nF/NC	C22	1	
25	SMT capacitor	0603 10nF 10% 50V	C23	1	
26	SMT capacitor	0603 10nF 10% 50V	C25	1	
27	SMT capacitor	0603 10nF 10% 50V	C24 C27	1	
28	SMT resistor	0603 0Ω 1%	R20 R22 R23 R25	4	
29	SMT resistor	0603 3.3kΩ 1%	R26 R31 R32	3	
30	SMT resistor	0603 33kΩ 1%	R30 R33	2	
31	SMT resistor	1206 20mΩ 1%	R27	1	
32	SMT resistor	0603 22kΩ 1%	R19	1	
33	SMT resistor	0603 200kΩ 1%	R34 R35	2	
34	SMT MOS	PDFN3*3-8L AP20G02BDF	N1 N2	2	
35	SMT NMOS	SOT-23 2N7002	N3	1	
36	SMT resistor	0603 3.3kΩ 1%	R28 R29	2	
37	Coil	A11	W1	1	

38	IC	CPC8-5 IP3036	U2 U3	2	Lithium protection circuit BOM
39	SMT capacitor	0603 100nF 10% 16V	C28	1	
40	SMT resistor	0603 1kΩ 1%	R36	1	
41	IC	IP2610H	U4	1	
42	SMT capacitor	0603 1nF 10% 25V	C31 C32	2	
43	SMT resistor	0603 1kΩ 1%	R37	1	
44	SMT resistor	0603 10kΩ 1%	R38 R40	2	
45	SMT resistor	0603 100kΩ 1%	R39	1	
46	Voltage regulator tube	10V	D10	1	
47	SMT NMOS	SOT-23 AO3401	N4	1	
48	SMT PNP	3906	N5	1	

## 14.2. Power bank+TX+188 application

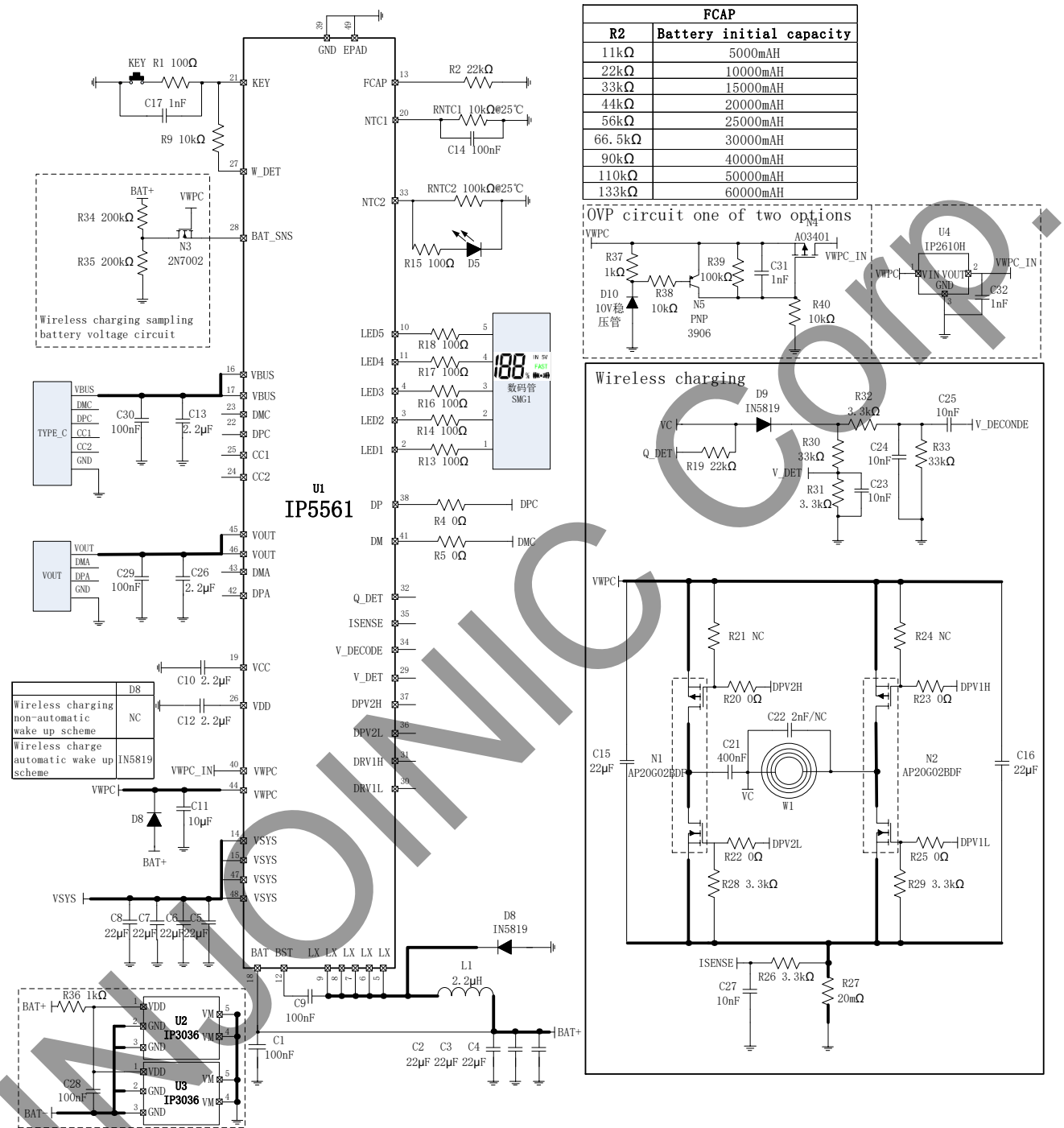


Figure 31 IP5561\_188 Nixie tube application circuit

**BOM 表**

No.	Part Name	Type	Location	Num	Note
1	IC	QFN48 IP5561	U1	1	
2	SMT capacitor	0603 100nF 10% 25V	C1 C9 C14 C29 C30	5	
3	SMT capacitor	0805 22μF 10% 16V	C2 C3 C4	3	
4	SMT capacitor	0805 22μF 10% 25V	C5 C6 C7 C8	4	
5	SMT capacitor	0603 2.2μF 10% 25V	C10 C12 C13 C26	4	
6	SMT capacitor	0603 1nF 10% 25V	C17	1	
7	SMT capacitor	0603 10μF 10% 25V	C11	1	
8	SMT capacitor	CAP-5-5 100μF	CP1	1	
9	SMT Schottky	IN5819	D8 D9	2	
10	KEY	SMT 3*6	KEY	1	
11	Inductor	2.2μH 10*10	L1	1	
12	output USB	AF10 8 USB	VOUT	1	
13	USB C CONNECTOR	USB C connector	TYPE-C	1	
14	SMT resistor	0603 100Ω 1%	R1	1	
15	SMT resistor	0603 22kΩ 1%	R2	1	
16	SMT resistor	0603 10kΩ 1%	R9	1	
17	SMT resistor	0603 0Ω 1%	R4 R5	2	
18	SMT resistor	0603 100Ω 1%	R13 R14 R15 R16 R17 R18	6	
19	SMT LED	0603	D5	1	
20	NTC thermal resistor	10 kΩ@25°C B=3380	RNTC1	1	
21	NTC thermal resistor	100 kΩ@25°C B=3950	RNTC2	1	
22	SMT diode	YFTD2715AWPG-5D	SMG1	1	
23	SMT capacitor	0805 22μF 10% 25V	C15 C16	2	Wireless charging circuit BOM
24	CBB resonant capacitor	400nF 100V	C21	1	
25	SMT capacitor	0603 2nF/NC	C22	1	
26	SMT capacitor	0603 10nF 10% 50V	C23	1	
27	SMT capacitor	0603 10nF 10% 50V	C25	1	
28	SMT capacitor	0603 10nF 10% 50V	C24 C27	1	
29	SMT resistor	0603 0Ω 1%	R20 R22 R23 R25	4	
30	SMT resistor	0603 3.3kΩ	R26 R31 R32	3	
31	SMT resistor	0603 33kΩ	R30 R33	2	
32	SMT resistor	1206 20mΩ 1%	R27	1	
33	SMT resistor	0603 22kΩ 1%	R19	1	
34	SMT resistor	0603 200kΩ 1%	R34 R35	2	
35	SMT MOS	PDFN3*3-8L AP20G02BDF	N1 N2	2	
36	SMT resistor	0603 3.3kΩ 1%	R28 R29	2	



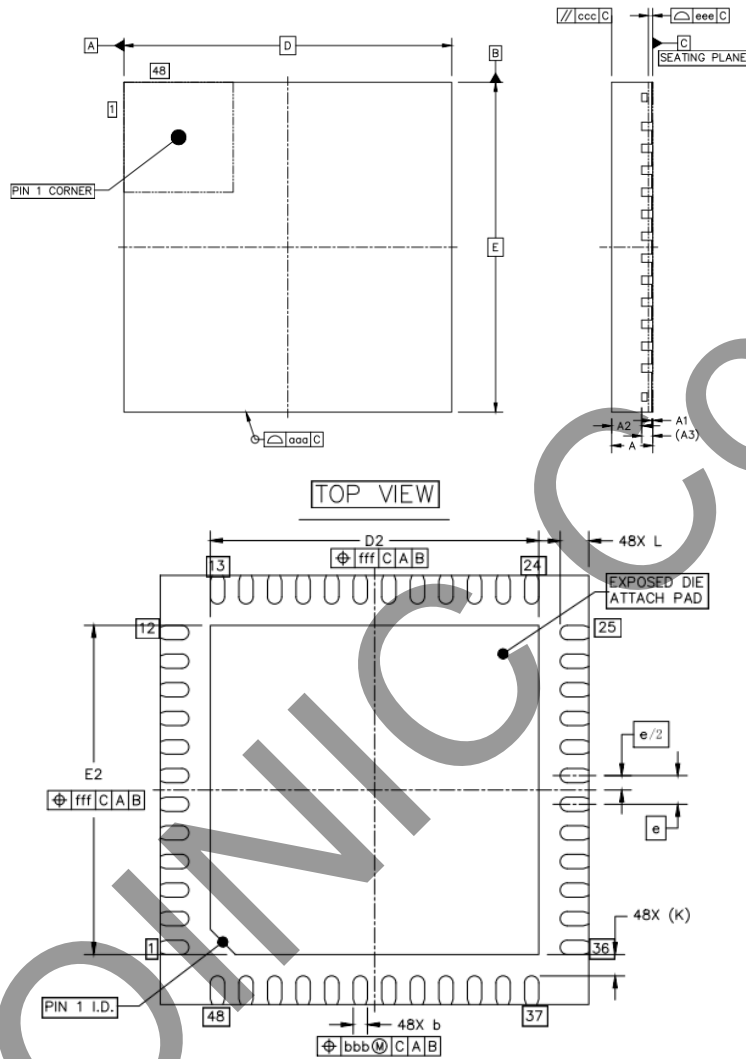
37	SMT NMOS	SOT-23 2N7002	N3	1	Lithium protection circuit BOM
38	Coil	A11	W1	1	
39	IC	CPC8-5 IP3036	U2 U3	2	
40	SMT capacitor	0603 100nF 10% 16V	C28	1	
41	SMT resistor	0603 1kΩ 1%	R36	1	
42	IC	IP2610H	U4	1	
43	SMT capacitor	0603 1nF 10% 25V	C31 C32	2	
44	SMT resistor	0603 1kΩ 1%	R37	1	
45	SMT resistor	0603 10kΩ 1%	R38 R40	2	
46	SMT resistor	0603 100kΩ 1%	R39	1	
47	Voltage regulator tube	10V	D10	1	
48	NMOS	SOT-23 AO3401	N4	1	
49	PNP	3906	N5	1	

### Recommended inductance model

DARFON PIN	Thickness (mm)	Inductance (μH)	Tolerance	DC Resistance (mΩ)		Heat Rating	Saturation	Measuring Condition
				Typ.	Max.	Current	Current	
						DC Amp.	DC Amps.	
SPM70702R2MESQ	5	2.2	±20%	9	10.2	Idc(A)Max. 10.5	Isat(A)Max. 13.5	100kHz / 1.0V
SPM10102R2MESN	4	2.2	±20%	6	7	12	18	100kHz / 1.0V
SHC1004-2R2M	4	2.2	±20%	7	9	12	24	

## 15. Package

### 15.1. Chip package



	SYMBOL	MIN	NOM	MAX	
TOTAL THICKNESS	A	0.7	0.75	0.8	
STAND OFF	A1	0	0.02	0.05	
MOLD THICKNESS	A2	---	0.55	---	
L/F THICKNESS	A3		0.203 REF		
LEAD WIDTH	b	0.15	0.2	0.25	
BODY SIZE	X	D		6 BSC	
	Y	E		6 BSC	
LEAD PITCH	e		0.4 BSC		
EP SIZE	X	D2	4.5	4.6	4.7
	Y	E2	4.5	4.6	4.7
LEAD LENGTH	L	0.3	0.4	0.5	
LEAD TIP TO EXPOSED PAD EDGE	K		0.3 REF		
PACKAGE EDGE TOLERANCE	aaa		0.1		
MOLD FLATNESS	ccc		0.1		
COPLANARITY	eee		0.08		
LEAD OFFSET	bbb		0.07		
EXPOSED PAD OFFSET	fff		0.1		

## 15.2. Silk Screen Description



说明:



- 1、 --Injoinic Logo
- 2、IP5561 --Part Number
- 3、XXXXXXXX --Manufacture lot number
- 4、 --Pin1 location

Figure 32 Silk Screen Description

## 16. IMPORTANT NOTICE

INJOINIC TECHNOLOGY and its subsidiaries reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as “components”) are sold subject to INJOINIC TECHNOLOGY’s terms and conditions of sale supplied at the time of order acknowledgment.

INJOINIC TECHNOLOGY assumes no liability for applications assistance or the design of Buyers’ products. Buyers are responsible for their products and applications using INJOINIC TECHNOLOGY’s components. To minimize the risks associated with Buyers’ products and applications, Buyers should provide adequate design and operating safeguards.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of INJOINIC TECHNOLOGY’s components in its applications, notwithstanding any applications-related information or support that may be provided by INJOINIC TECHNOLOGY. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify INJOINIC TECHNOLOGY and its representatives against any damages arising out of the use of any INJOINIC TECHNOLOGY’s components in safety-critical applications.

Reproduction of significant portions of INJOINIC TECHNOLOGY’s information in INJOINIC TECHNOLOGY’s data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. INJOINIC TECHNOLOGY is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

INJOINIC TECHNOLOGY will update this document from time to time. The actual parameters of the product may vary due to different models or other items. This document voids all express and any implied warranties.

Resale of INJOINIC TECHNOLOGY’s components or services with statements different from or beyond the parameters stated by INJOINIC TECHNOLOGY for that component or service voids all express and any implied warranties for the associated INJOINIC TECHNOLOGY’s component or service and is an unfair and deceptive business practice. INJOINIC TECHNOLOGY is not responsible or liable for any such statements.